INCH-POUND MIL-M-38510/129B 06 December 2004 SUPERSEDING MIL-M-38510/129A 06 December 1985

MILITARY SPECIFICATION

MICROCIRCUITS, MONOLITHIC SILICON INTERFACE, DUAL PERIPHERAL DRIVERS

Reactivated after 06 December 2004 and may be used for either new or existing design acquisition.

This specification is approved for use by all Departments and Agencies of the Department of Defense.

The requirements for acquiring the product herein shall consist of this specification sheet and MIL-PRF-38535.

1. SCOPE

1.1 <u>Scope.</u> This specification covers the detail requirements for bipolar, monolithic silicon, dual peripheral drivers. Two product assurance classes and a choice of case outlines and lead finishes are provided and are reflected in the complete part number. For this product, the requirements of MIL-M-38510 have been superseded by MIL-PRF-38535, (see 6.3)

- 1.2 Part or Identifying Number (PIN). The PIN is in accordance with MIL-PRF-38535, and as specified herein.
- 1.2.1 <u>Device types.</u> The device types are as follows:

Device types	Circuit
01	Dual NAND/AND gate and transistor (separate), high speed switching
02	Dual AND gate and transistor (connected), high speed switching
03	Dual NAND gate and transistor (connected), high speed switching
04	Dual OR gate and transistor (connected), high speed switching
05	Dual NOR gate and transistor (connected), high speed switching
06	High voltage dual NAND/AND gate and transistor (separate), medium speed switching
07	High voltage dual AND gate and transistor (connected), medium speed switching
08	High voltage dual NAND gate and transistor (connected), medium speed switching
09	High voltage dual OR gate and transistor (connected), medium speed switching
10	High voltage dual NOR gate and transistor (connected), medium speed switching

- 1.2.2 <u>Device class</u>. The device class is the product assurance level as defined in MIL-PRF-38535.
- 1.2.3 Case outline. The case outlines are as designated in MIL-STD-1835 and as follows:

Outline letter	Descriptive designator	<u>Terminals</u>	Package style
C	GDIP1-T14 or CDIP2-T14	14	Dual in line
P	GDIP1-T8 or CDIP2-T8	8	Dual in line

Comments, suggestions, or questions on this document should be addressed to: Commander, Defense Supply Center Columbus, ATTN: DSCC-VAS, 3990 East Broad St., Columbus, OH 43218-3990, or email Linear@dscc.dla.mil. Since contact information can change, you may want to verify the currency of this address information using the ASSIST Online database at http://assist.daps.dla.mil.

1.3 Absolute maximum ratings.

	Supply voltage (V _{CC})	7 V dc	
	Input voltage (V _{IN})		
	Interemitter voltage (V _{EM})		
	V _{CC} to substrate voltage (V _{CCS}):		
	Device type 01		
	Device type 06	40 V dc	
	Collector to substrate voltage (V _{CS}): Device type 01	25 \/ do	
	Device type 01		
	Collector to base voltage (V _{EB}):		
	Device type 01		
	Device type 06	40 V dc	
	Collector to emitter voltage (V _{CER}):	20.)/ da	
	Device type 01 Device type 06		
	Collector to emitter voltage (V _{CEO}):		
	Device type 06	25 V dc	
	Emitter to base voltage (VBE):		
	Device types 01 and 06	5 V dc	
	Offstate output voltage (V _{OO}):	00.1/	
	Device types 02 through 05 Device types 07 through 10		
	Continuous collector current (I _{CC}):		
	Device types 01 and 06	300 mA	
	Continuous output current (I _{OC}):		
	Device types 02 through 05 and 07 through 10	300 mA <u>1</u> /	
	Peak collector current (I _{CP}):	500 4	
	Device types 01 and 06	500 mA	
	Peak output current (I _{OP}): Device types 02 through 05 and 07 through 10	500 mA	
	Continuous total dissipation at 25°C ambient:	000 111/1	
	Device types 01 and 06		
	Device types 02 through 05 and 07 through 10		
	Ambient operating temperature range		
	Junction temperature (T _J)		
	Lead temperature 1/16 inch from case, (soldering, 60 seconds)		
1	.4 <u>Recommended operating conditions.</u>		
	Supply voltage range	+4.5 V to +5.5 V 2	<u>!/</u>
	Ambient operating temperature range (TA)	-55°C to +125°C	

<u>1/</u> Both halves of these dual circuits may conduct rated current simultaneously; however, power

dissipation averaged over a short time interval must fall within the continuous power dissipation ratings. 2/ For device types 01 and 06 only, the substrate (pin 8) must always be at the most negative device voltage for proper operation.

1.5 Power and thermal characteristics.

Package	Case outline	Maximum allowable power dissipation	Maximum θ_{JC}	Maximum θ _{JA}
14 lead dual in line	С	275 mW at T _A = +125°C	29°C/W	91°C/W
8 lead dual in line	Р	210 mW at T _A = +125°C	26°C/W	119°C/W

2. APPLICABLE DOCUMENTS

2.1 <u>General</u>. The documents listed in this section are specified in sections 3, 4, or 5 of this specification. This section does not include documents cited in other sections of this specification or recommended for additional information or as examples. While every effort has been made to ensure the completeness of this list, document users are cautioned that they must meet all specified requirements of documents cited in sections 3, 4, or 5 of this specification, whether or not they are listed.

2.2 Government documents.

2.2.1 <u>Specifications, standards, and handbooks</u>. The following specifications and standards form a part of this specification to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

DEPARTMENT OF DEFENSE SPECIFICATIONS

MIL-PRF-38535 - Integrated Circuits (Microcircuits) Manufacturing, General Specification for.

DEPARTMENT OF DEFENSE STANDARDS

MIL-STD-883 - Test Method Standard for Microelectronics.

MIL-STD-1835 - Interface Standard Electronic Component Case Outlines.

(Copies of these documents are available online at <u>http://assist.daps.dla.mil/quicksearch/</u> or <u>http://assist.daps.dla.mil</u> or from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.3 <u>Order of precedence</u>. In the event of a conflict between the text of this specification and the references cited herein the text of this document shall takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 <u>Qualification</u>. Microcircuits furnished under this specification shall be products that are manufactured by a manufacturer authorized by the qualifying activity for listing on the applicable qualified manufacturers list before contract award (see 4.3 and 6.4).

3.2 <u>Item requirements</u>. The individual item requirements shall be in accordance with MIL-PRF-38535 and as specified herein or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein.

3.3 <u>Design, construction, and physical dimensions</u>. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535 and herein.

3.3.1 Logic diagrams and terminal connections. The logic diagrams and terminal connections shall be as specified on figure 1.

3.3.2 Truth tables. The truth tables shall be as specified on figure 2.

3.3.3 <u>Schematic circuits</u>. The schematic circuits shall be maintained by the manufacturer and made available to the qualifying activity and the preparing activity upon request.

3.3.4 Case outlines. The case outlines shall be as specified in 1.2.3.

3.3.5 Package and sealing material. Package and sealing material shall be in accordance with MIL-PRF-38535.

3.4 Lead material and finish. The lead material and finish shall be in accordance with MIL-PRF-38535 (see 6.6).

3.5 <u>Electrical performance characteristics</u>. The electrical performance characteristics are as specified in table I, and apply over the full recommended ambient operating temperature range, unless otherwise specified.

3.6 <u>Electrical test requirements</u>. Electrical test requirements for each device class shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table III.

3.7 Marking. Marking shall be in accordance with MIL-PRF-38535.

3.8 <u>Microcircuit group assignment</u>. The devices covered by this specification shall be in microcircuit group number 53 (see MIL-PRF-38535, appendix A).

		Conditions	Device	Lin	nits	
Test	Symbol	$\label{eq:table_state} -55^\circ C \leq T_A \leq +125^\circ C$ unless otherwise specified	type	Min	Max	Units
Input clamp voltage	VIC	V _{CC} = 4.5 V, I _{IN} = -12 mA	All		-1.5	V
High level input currents into A or B	l _{IH1}	V _{CC} = 5.5 V, V _{IN} = 2.4 V	All		40	μA
	I _{IH2}	V _{CC} = 5.5 V, V _{IN} = 5.5 V			1	mA
High level input current into G	I _{IH3}	V _{CC} = 5.5 V, V _{IN} = 2.4 V	01,06		80	μA
	I _{IH4}	V _{CC} = 5.5 V, V _{IN} = 5.5 V			2	mA
Low level input currents into A or B	l _{IL1}	V_{CC} = 5.5 V, V_{IN} = 0.4 V or 5.5 V	All		-1.6	mA
Low level input current into G	I _{IL2}	V_{CC} = 5.5 V, V_{IN} = 0.4 V or 5.5 V	01,06		-3.2	mA
High level supply current	ICCH1	V _{CC} = 5.5 V, V _{IN} = 0 V	01,06		4	mA
	I _{CCH2}	V _{CC} = 5.5 V, V _{IN} = 5.5 V	02,04, 07,09		11	
	Ісснз	V _{CC} = 5.5 V, V _{IN} = 0 V	05,08		17	
	I _{CCH4}	V _{CC} = 5.5 V, V _{IN} = 0 V	03		14	
	ICCH5	V _{CC} = 5.5 V, V _{IN} = 0 V	10		10	
Low level supply current	ICCL1	V _{CC} = 5.5 V, V _{IN} = 5.5 V	01,06		11	mA
	ICCL2	V _{CC} = 5.5 V, V _{IN} = 0 V	02		65	
	I _{CCL3}	V _{CC} = 5.5 V, V _{IN} = 0 V	04		63	
	I _{CCL4}	V _{CC} = 5.5 V, V _{IN} = 5.5 V	03		71	
	I _{CCL5}	V _{CC} = 5.5 V, V _{IN} = 0 V	07,09		76	
	ICCL6	V _{CC} = 5.5 V, V _{IN} = 5.5 V	08		76	
	ICCL7	V _{CC} = 5.5 V, V _{IN} = 5.5 V	05		79	
	I _{CCL8}	V _{CC} = 5.5 V, V _{IN} = 5.5 V	10		85	

TABLE I.	Electrical performance characteristics

		Conditions	Device	Lin	nits	
Test	Symbol	-55°C \leq T _A \leq +125°C unless otherwise specified	type	Min	Max	Units
Low level output	VOL1	$V_{CC} = 4.5 \text{ V}, \text{ V}_{IN} = 0.8 \text{ V} \text{ or } 4.5 \text{ V};$	02, 07		0.5	V
voltage		I _{OL} = 100 mA				
	V _{OL2}	V_{CC} = 4.5 V, V_{IN} = 2 V, I_{OL} = 100 mA	03, 08		0.5	
	V _{OL3}	$V_{CC} = 4.5 \text{ V}, \text{ V}_{IN} = 0.8 \text{ V}, \text{ I}_{OL} = 100 \text{ mA}$	04, 09		0.5	
	V _{OL4}	$V_{CC} = 4.5 \text{ V}, V_{IN} = 2 \text{ V or } 0 \text{ V},$ $I_{OL} = 100 \text{ mA}$	05, 10		0.5	
	V _{OL5}	$V_{CC} = 4.5 \text{ V}, V_{IN} = 0.8 \text{ V} \text{ or } 4.5 \text{ V},$ $I_{OL} = 300 \text{ mA}$	02, 07		0.8	
	V _{OL6}	$V_{CC} = 4.5 \text{ V}, \text{ V}_{IN} = 2 \text{ V}, \text{ I}_{OL} = 300 \text{ mA}$	03, 08		0.8	
	V _{OL7}	$V_{CC} = 4.5 \text{ V}, V_{IN} = 0.8 \text{ V}, I_{OL} = 300 \text{ mA}$	04, 09		0.8	
	V _{OL8}	$V_{CC} = 4.5 \text{ V}, V_{IN} = 2 \text{ V or } 0 \text{ V},$ $I_{OL} = 300 \text{ mA}$	05, 10		0.8	
Low level output voltage, TTL gate	V _{OL9}	V_{CC} = 4.5 V, V_{IN} = 2 V, I_O = 16 mA	01, 06		0.5	V
High level output current	I _{OH1}	V_{CC} = 4.5 V, V_{OH} = 30 V, V_{IN} = 2 V	02,07		300	μΑ
	I _{OH2}	V _{CC} = 4.5 V, V _{OH} = 30 V, V _{IN} = 0.8 V or 4.5 V	03,08		300	
	I _{OH3}	$V_{CC} = 4.5 \text{ V}, V_{OH} = 30 \text{ V},$ $V_{IN} = 2 \text{ V or } 0 \text{ V}$	04,09		300	
	I _{OH4}	V _{CC} = 4.5 V, V _{OH} = 30 V, V _{IN} = 0.8 V	05,10		300	
High level output voltage, TTL gate	V _{OH}	$V_{CC} = 4.5 \text{ V}, \text{ V}_{IN} = 0.8 \text{ V},$ $I_{OL} = -400 \mu\text{A}$	01,06	2.4		V
Short circuit output current, TTL gate	I _{OS1}	V _{CC} = 5.5 V	01,06		-55	mA
	I _{OS2}	V _{CC} = 4.5 V		-18		
Collector base breakdown voltage	V _{CB01}	I _C = 100 μA, I _E = 0	01	35		V
, , , , , , , , , , , , , , , , , , ,	V _{CB02}	I _C = 100 μA, I _E = 0	06	40		
Collector emitter breakdown voltage	V _{CER1}	I _C = 100 μA, R _{BE} = 500 Ω	01	35		V
	V _{CER2}	I _C = 100 μA, R _{BE} = 500 Ω	06	40		

 TABLE I.
 Electrical performance characteristics
 – Continued.

		Conditions	Device	Lin	nits	
Test	Symbol	-55°C \leq T _A \leq +125°C unless otherwise specified	type	Min	Max	Units
Collector emitter breakdown voltage	V _{CE01}	I _C = 10 mA	06	25		V
Emitter base breakdown voltage	V _{EBO}	$I_E = 100 \ \mu A, \ I_C = 0$	01,06	5		V
Static forward current transfer ratio	hFE1	$V_{CE} = 3 \text{ V}, \text{ I}_{C} = 100 \text{ mA}, \text{ V}_{S} = 4 \text{ V},$ $T_{A} = +25^{\circ}\text{C}, +125^{\circ}\text{C}$	01,06	25		
	h _{FE2}	$V_{CE} = 3 \text{ V}, \text{ I}_{C} = 300 \text{ mA}, \text{ V}_{S} = 6 \text{ V},$ $T_{A} = +25^{\circ}\text{C}, +125^{\circ}\text{C}$		30		
	h _{FE3}	$V_{CE} = 3 \text{ V}, \text{ I}_{C} = 100 \text{ mA}, \text{ V}_{S} = 4 \text{ V},$ $T_{A} = -55^{\circ}\text{C}$		10		
	h _{FE4}	$V_{CE} = 3 \text{ V}, \text{ I}_{C} = 300 \text{ mA}, \text{ V}_{S} = 6 \text{ V},$ $T_{A} = -55^{\circ}\text{C}$		15		
Base emitter voltage	V _{BE1}	I _B = 10 mA, I _C = 100 mA	01,06		1.2	V
	V _{BE2}	I _B = 30 mA, I _C = 300 mA			1.4	
Collector emitter saturation voltage	V _{CESAT1}	I _B = 10 mA, I _C = 100 mA	01,06		0.5	V
Saturation voltage	V _{CESAT2}	I _B = 30 mA, I _C = 300 mA			0.8	
Delay time	tD	I_{C} = 200 mA, R _L = 50 Ω, C _L = 100 pF, V _{BE} = -1 V, I _B = 20 mA, T _A = +25°C	01,06		15	ns
		$\label{eq:LC} \begin{split} I_{C} &= 200 \text{ mA}, R_{L} = 50 \; \Omega, C_{L} = 100 \; p\text{F}, \\ V_{BE} &= -1 \; V, I_{B} = 20 \; \text{mA}, \\ -55^{\circ}\text{C} \leq T_{A} \leq +125^{\circ}\text{C} \end{split}$			22.5	
Rise time	t _R	I_{C} = 200 mA, R _L = 50 Ω, C _L = 100 pF, V _{BE} = -1 V, I _B = 20 mA, T _A = +25°C	01,06		20	ns
		$\begin{split} I_{C} &= 200 \text{ mA}, \text{ R}_{L} = 50 \ \Omega, \text{ C}_{L} = 100 \text{ pF}, \\ V_{BE} &= -1 \ V, \text{ I}_{B} = 20 \text{ mA}, \\ -55^{\circ}\text{C} &\leq \text{T}_{A} \leq +125^{\circ}\text{C} \end{split}$			30	
Storage time	ts	I_{C} = 200 mA, R _L = 50 Ω, C _L = 100 pF, V _{BE} = -1 V, I _B = 20 mA, T _A = +25°C	01		15	ns
		I_{C} = 200 mA, R _L = 50 Ω, C _L = 100 pF, V _{BE} = -1 V, I _B = 20 mA, -55°C ≤ T _A ≤ +125°C			22.5	

TABLE I.	Electrical	performance	characteristics -	- Continued.

		Conditions	Device	Lin	nits	
Test	Symbol	-55°C \leq T _A \leq +125°C unless otherwise specified	type	Min	Max	Units
Storage time	ts	$I_{C} = 200 \text{ mA}, R_{L} = 50 \Omega, C_{L} = 100 \text{ pF},$ $V_{BE} = -1 \text{ V}, I_{B} = 20 \text{ mA}, T_{A} = +25^{\circ}\text{C}$	06		23	ns
		$\label{eq:LC} \begin{array}{l} I_{C} = 200 \text{ mA}, \ R_{L} = 50 \ \Omega, \ C_{L} = 100 \ \text{pF}, \\ V_{BE} = -1 \ \text{V}, \ I_{B} = 20 \ \text{mA}, \\ -55^{\circ}\text{C} \leq T_{A} \leq +125^{\circ}\text{C} \end{array}$			34.5	
Fall time	tF	I_{C} = 200 mA, R _L = 50 Ω , C _L = 100 pF, V _{BE} = -1 V, I _B = 20 mA, T _A = +25°C	01,06		15	ns
		$\begin{split} I_{C} &= 200 \text{ mA}, \text{ R}_{L} = 50 \ \Omega, \text{ C}_{L} = 100 \text{ pF}, \\ V_{BE} &= -1 \text{ V}, \text{ I}_{B} = 20 \text{ mA}, \\ -55^{\circ}\text{C} &\leq \text{T}_{A} \leq +125^{\circ}\text{C} \end{split}$			22.5	
Propagation delay time (low to high level output) TTL gate	tPLH1	C_L = 100 pF, R _L = 400 Ω, V _{CC} = 4.5 V, T _A = +25°C	01,06		30	ns
		$\label{eq:CL} \begin{split} C_L &= 100 \text{ pF}, \text{R}_L = 400 \ \Omega, \text{V}_{CC} = 4.5 \text{V}, \\ \text{-}55^\circ\text{C} \leq \text{T}_A \leq +125^\circ\text{C} \end{split}$			45	
Propagation delay time (low to high level output)	tPLH2	I _C = 200 mA, C _L = 100 pF, R _L = 50 Ω, V _{CC} = 4.5 V, T _A = +25°C	01		30	ns
		I_{C} = 200 mA, C _L = 100 pF, R _L = 50 Ω, V _{CC} = 4.5 V, -55°C ≤ T _A ≤ +125°C			45	
	tPLH3	I _C = 200 mA, C _L = 100 pF, R _L = 50 Ω, V _{CC} = 4.5 V, T _A = +25°C	06		65	
		I_{C} = 200 mA, C _L = 100 pF, R _L = 50 Ω, V _{CC} = 4.5 V, -55°C ≤ T _A ≤ +125°C			90	
Propagation delay time (high to low level output) TTL gate	^t PHL1	C_L = 100 pF, R _L = 400 Ω, T _A = +25°C	01,06		15	ns
		$\label{eq:L} \begin{split} C_L &= 100 \text{ pF}, R_L = 400 \ \Omega, \\ -55^\circ C &\leq T_A \leq +125^\circ C \end{split}$			22.5	
Propagation delay time (high to low level output)	tPHL2	I _C = 200 mA, C _L = 100 pF, R _L = 50 Ω, T _A = +25°C	01		30	ns
		I _C = 200 mA, C _L = 100 pF, R _L = 50 Ω, -55°C \leq T _A \leq +125°C			45	
	tphl3	I _C = 200 mA, C _L = 100 pF, R _L = 50 Ω, T _A = +25°C	01		50	
		I_{C} = 200 mA, C_{L} = 100 pF, R_{L} = 50 Ω , -55°C ≤ T_{A} ≤ +125°C			75	

TABLE I.	Electrical	performance	characteristics	- Continued.
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		Conditions	Device	Lin	nits	
Test	Symbol	-55°C \leq T _A \leq +125°C unless otherwise specified	type	Min	Max	Units
Transition time (low to high level output)	ttlH1	I _C = 200 mA, C _L = 100 pF, R _L = 50 Ω, T _A = +25°C	01		15	ns
		$\label{eq:loss} \begin{array}{l} I_C = 200 \text{ mA}, \ C_L = 100 \text{ pF}, \ R_L = 50 \ \Omega, \\ -55^\circ C \leq T_A \leq +125^\circ C \end{array}$			22.5	
	tTLH2	I_{C} = 200 mA, C _L = 100 pF, R _L = 50 Ω, T _A = +25°C	06		20	
		$\label{eq:lc} \begin{array}{l} I_C = 200 \text{ mA}, C_L = 100 \text{ pF}, R_L = 50 \ \Omega, \\ \\ -55^\circ C \leq T_A \leq +125^\circ C \end{array}$			30	
Transition time (high to low level output)	tTHL1	I _C = 200 mA, C _L = 100 pF, R _L = 50 Ω, T _A = +25°C	01		15	ns
		$\label{eq:loss} \begin{array}{l} I_C = 200 \text{ mA}, \ C_L = 100 \text{ pF}, \ R_L = 50 \ \Omega, \\ \\ -55^\circ C \leq T_A \leq +125^\circ C \end{array}$			22.5	
	tTHL2	I _C = 200 mA, C _L = 100 pF, R _L = 50 Ω, T _A = +25°C	06		20	
		$\label{eq:lc} \begin{split} I_C &= 200 \text{ mA}, \ C_L = 100 \text{ pF}, \ R_L = 50 \ \Omega, \\ -55^\circ\text{C} &\leq T_A \leq +125^\circ\text{C} \end{split}$			30	
Propagation delay time (low to high level output)	t _{PLH}	V_{CC} = 4.5 V, I _O = 200 mA, C _L = 100 pF, R _L = 50 Ω, T _A = +25°C	02,04		30	ns
		V_{CC} = 4.5 V, I _O = 200 mA, C _L = 100 pF, R _L = 50 Ω, -55°C ≤ T _A ≤ +125°C			45	
	tPLH	$V_{CC} = 4.5 \text{ V}, \text{ I}_{O} = 200 \text{ mA},$	03		35	
		$C_L = 100 \text{ pF}, R_L = 50 \Omega,$ $T_A = +25^{\circ}\text{C}$	05		45	
		V_{CC} = 4.5 V, I _O = 200 mA,	03		55	
		$\begin{split} C_L &= 100 \text{ pF}, \text{R}_L = 50 \Omega, \\ -55^\circ\text{C} &\leq \text{T}_\text{A} \leq +125^\circ\text{C} \end{split}$	05		75	
	tplh	V_{CC} = 4.5 V, I _O = 200 mA, C _L = 100 pF, R _L = 50 Ω, T _A = +25°C	07,09		55	
		$V_{CC} = 4.5 \text{ V}, \text{ I}_{O} = 200 \text{ mA},$	07		65	
		$\begin{split} C_L &= 100 \text{ pF}, \text{ R}_L = 50 \ \Omega, \\ &-55^\circ\text{C} \leq \text{T}_A \leq +125^\circ\text{C} \end{split}$	09		70	

TABLE I. Electrical perf	ormance characteristics –	Continued.
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		Conditions	Device	Lin	nits	
Test	Symbol	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	type	Min	Max	Units
		unless otherwise specified				
Propagation delay time	t _{PLH}	$V_{CC} = 4.5 \text{ V}, I_{O} = 200 \text{ mA},$	08,10		65	ns
(low to high level output)		$C_{L} = 100 \text{ pF}, \text{ R}_{L} = 50 \Omega,$				
ouipui)		T _A = +25°C				
		V _{CC} = 4.5 V, I _O = 200 mA,	08		95	
		C _L = 100 pF, R _L = 50 Ω,	10		90	
		$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	10		90	
Propagation delay time	tPHL	V _{CC} = 4.5 V, I _O = 200 mA,	02,04		30	ns
(high to low level		$C_{L} = 100 \text{ pF}, \text{ R}_{L} = 50 \Omega,$				
output)		$T_A = +25^{\circ}C$				
		$V_{CC} = 4.5 \text{ V}, I_{O} = 200 \text{ mA},$			45	
		$C_{L} = 100 \text{ pF}, R_{L} = 50 \Omega,$				
		$-55^{\circ}C \le T_{A} \le +125^{\circ}C$				
	tPHL	$V_{CC} = 4.5 \text{ V}, \text{ I}_{O} = 200 \text{ mA},$	03,05		35	
		$C_{L} = 100 \text{ pF}, R_{L} = 50 \Omega,$				
		$T_A = +25^{\circ}C$				
		V _{CC} = 4.5 V, I _O = 200 mA,			55	
		$C_{L} = 100 \text{ pF}, R_{L} = 50 \Omega,$				
		$-55^{\circ}C \le T_{A} \le +125^{\circ}C$				
	tPHL	$V_{CC} = 4.5 \text{ V}, I_{O} = 200 \text{ mA},$	07,09		40	
		$C_L = 100 \text{ pF}, R_L = 50 \Omega,$				
		$T_A = +25^{\circ}C$				
		$V_{CC} = 4.5 \text{ V}, \text{ I}_{O} = 200 \text{ mA},$			60	
		$C_L = 100 \text{ pF}, \text{ R}_L = 50 \Omega,$				
		$-55^{\circ}C \le T_{A} \le +125^{\circ}C$				
	tPHL	$V_{CC} = 4.5 \text{ V}, \text{ I}_{O} = 200 \text{ mA},$	08,10		50	
		$C_L = 100 \text{ pF}, \text{ R}_L = 50 \Omega,$				
		$T_A = +25^{\circ}C$				
		$V_{CC} = 4.5 \text{ V}, \text{ I}_{O} = 200 \text{ mA},$			75	
		$C_L = 100 \text{ pF}, \text{ R}_L = 50 \Omega,$				
		$-55^{\circ}C \le T_A \le +125^{\circ}C$				

 TABLE I.
 Electrical performance characteristics – Continued.

		Conditions	Device	Lin	nits	
Test	Symbol	-55°C \leq T _A \leq +125°C unless otherwise specified	type	Min	Max	Units
Transition time (low to high level output)	ttlh	V_{CC} = 4.5 V, I _O = 200 mA, C _L = 100 pF, R _L = 50 Ω, T _A = +25°C	02,03, 04,05		14	ns
		$V_{CC} = 4.5 V$, $I_O = 200 mA$, $C_L = 100 pF$, $R_L = 50 Ω$, $-55^{\circ}C \le T_A \le +125^{\circ}C$			18.5	
	tтLн	V_{CC} = 4.5 V, I _O = 200 mA, C _L = 100 pF, R _L = 50 Ω, T _A = +25°C	07,10		20	
		V_{CC} = 4.5 V, I _O = 200 mA, C _L = 100 pF, R _L = 50 Ω, -55°C ≤ T _A ≤ +125°C			26.5	
	ttlh	V_{CC} = 4.5 V, I _O = 200 mA, C _L = 100 pF, R _L = 50 Ω, T _A = +25°C	08,09		25	
		V_{CC} = 4.5 V, I _O = 200 mA, C _L = 100 pF, R _L = 50 Ω, -55°C ≤ T _A ≤ +125°C			33.5	
Transition time (high to low level output)	t _{THL}	V_{CC} = 4.5 V, I _O = 200 mA, C _L = 100 pF, R _L = 50 Ω, T _A = +25°C	02,03, 04,05		20	ns
		V_{CC} = 4.5 V, I _O = 200 mA, C _L = 100 pF, R _L = 50 Ω, -55°C ≤ T _A ≤ +125°C			25	
	t _{THL}	V_{CC} = 4.5 V, I _O = 200 mA, C _L = 100 pF, R _L = 50 Ω, T _A = +25°C	07,08,10		20	
		$V_{CC} = 4.5 \text{ V}, \text{ I}_{O} = 200 \text{ mA},$	07,10		25	
		$\begin{split} C_{L} &= 100 \text{ pF, } R_{L} = 50 \ \Omega, \\ -55^{\circ}\text{C} &\leq T_{A} \leq +125^{\circ}\text{C} \end{split}$	08		35	
	t _{THL}	V_{CC} = 4.5 V, I _O = 200 mA, C _L = 100 pF, R _L = 50 Ω, T _A = +25°C	09		25	

TABLE I. Electrical performance characteristics – Continu	ed.
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	Subgroups (see table III)
MIL-PRF-38535	Class S	Class B
test requirements	devices	devices
Interim electrical parameters	1	1
Final electrical test parameters	1*, 2, 3, 9	1*, 2, 3, 9
Group A test requirements	1, 2, 3, 9,	1, 2, 3, 9,
	10, 11	10, 11
Group B electrical test parameters when	1, 2, 3, and	N/A
using the method 5005 QCI option	table IV	
	delta limits	
Group C end-point electrical	1, 2, 3, and	1 and
parameters	table IV	table IV
	delta limits	delta limits
Group D end-point electrical	1, 2, 3	1
parameters		

TABLE II. Electrical test requirements.

*PDA applies to subgroup 1.

4. VERIFICATION.

4.1 <u>Sampling and inspection</u>. Sampling and inspection procedures shall be in accordance with MIL-PRF-38535 or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not effect the form, fit, or function as described herein.

4.2 <u>Screening</u>. Screening shall be in accordance with MIL-PRF-38535, and shall be conducted on all devices prior to qualification and quality conformance inspection. The following additional criteria shall apply:

- a. The burn-in test duration, test condition, and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document control by the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015 of MIL-STD-883.
- b. Interim and final electrical test parameters shall be as specified in table II, except interim electrical parameters test prior to burn-in is optional at the discretion of the manufacturer.
- c. Additional screening for space level product shall be as specified in MIL-PRF-38535.

4.3 <u>Qualification inspection</u>. Qualification inspection shall be in accordance with MIL-PRF-38535.

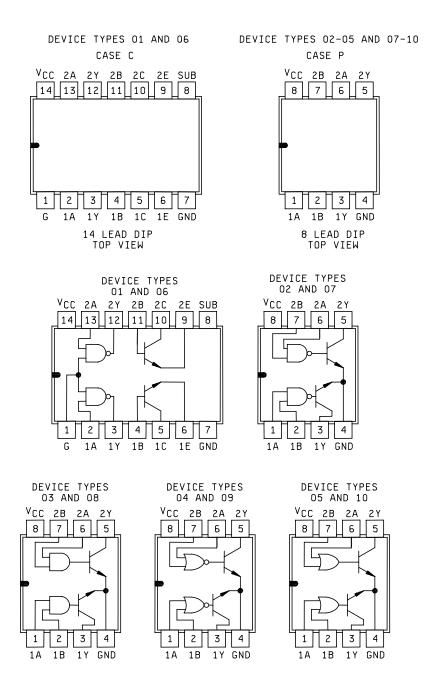


Figure 1. Logic diagrams and terminal connections.

Device	types
~ 4	~ ~

	01, 06		
Α	G	Y	Y'
0	0	1	0
0	1	1	0
1	0	1	0
1	1	0	1

Y is output at the gate. Y' is output at the transistor with the gate connected to the base of the transistor.

Device types 02. 07

	02, 07		
Α	В	Y	OUTPUT
0	0	0	ON
0	1	0	ON
1	0	0	ON
1	1	1	OFF



	03, 08		
А	В	Y	OUTPUT
0	0	1	OFF
0	1	1	OFF
1	0	1	OFF
1	1	0	ON

De	evice typ 04, 09	es	
А	В	Y	OUTPUT
0	0	0	ON
0	1	1	OFF
1	0	1	OFF
1	1	1	OFF

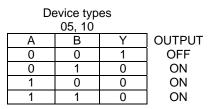
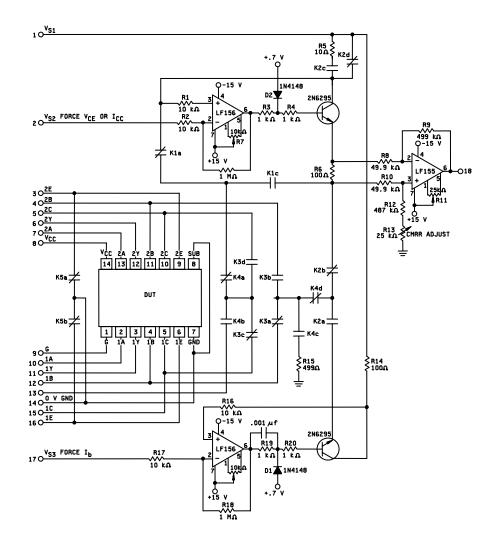
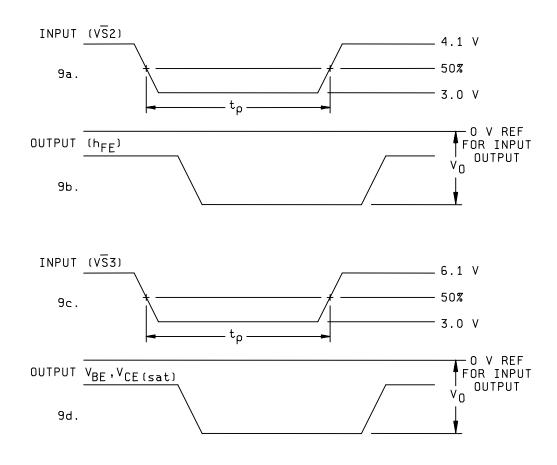


Figure 2. Truth tables.



- The output offset voltage shall be adjusted to zero volts with the device under test (DUT) removed. The operational amplifier stabilization networks may vary with test adapter construction. Alternative drive circuits for the 2N6295 may be used to develop the proper forcing currents and input voltage pulses. These circuits shall require the approval of the qualifying activity.
- 2. Relay switch positions are defined in table III.
- 3. Resistors R5, R6, R14 shall have a tolerance $\leq 0.1\%$ for device types 01, 06.
- 4. Reference figure 4 for input and output waveforms for device types 01, 06.

FIGURE 3. Test circuit for static tests, device types 01 and 06.



1. The pulse generator shall have the following characteristics:

PRR = 1 kHz,
$$t_p = 20 \ \mu s$$
, $Z_{out} \cong 50 \ \Omega$, t_r , $t_f = 10 \ ns$.

- 2. All V_O measurements are referenced to 0 V GND.
- 3. Use figures 4a and 4b for tests 23 26 and figures 4a, 4c, and 4d for tests 27 34.

FIGURE 4. hFE, VBE, VCE(sat) waveforms for table III, device types 01 and 06.

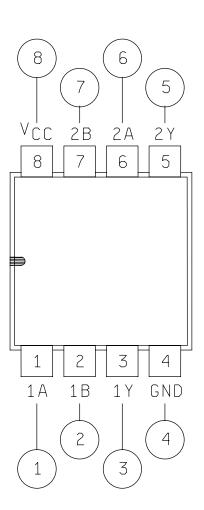
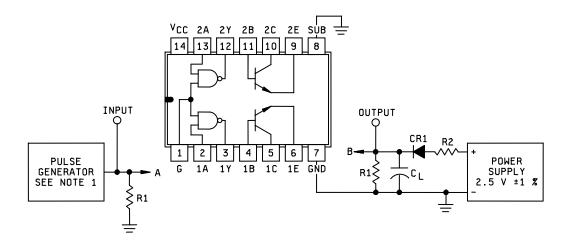
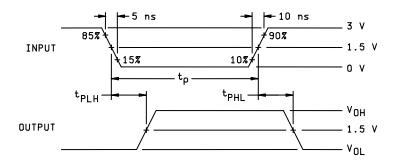


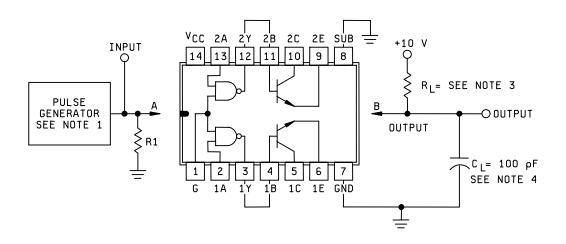
Figure 5. Test circuit for static tests, device types 02 through 05 and 07 through 10.

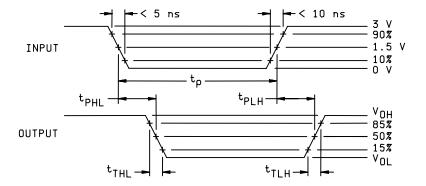




- 1. The pulse generator shall have the following characteristics: PRR = 1 MHz, t_p = 0.5 μ s, Z_{out} \cong 50 Ω .
- 2. R1 = 6.04 k $\Omega \pm 1$ percent, 1/8 watt.
- 3. $C_L = 100 \text{ pF}, \pm 5 \text{ pF}$ (including probe and parasitic capacitance).
- 4. Select R2 for a current flow of 16 mA \pm 1% out of Point B with Point L held at 0.5 volts. 5. CR1 = 1N4150 or equivalent.
- 6. R1 = 51 $\Omega \pm 5\%$ carbon.

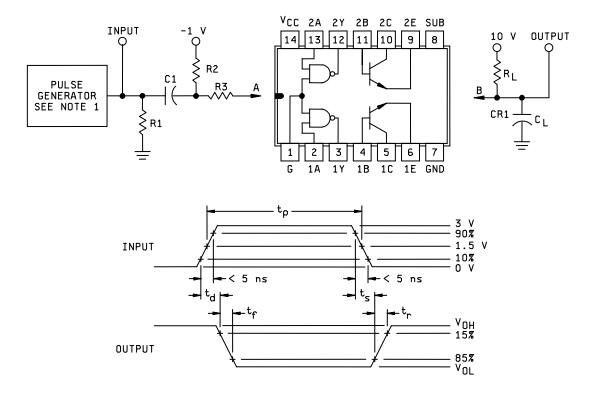
Figure 6. Propagation delay time waveforms (TTL gates only), for device types 01 and 06.





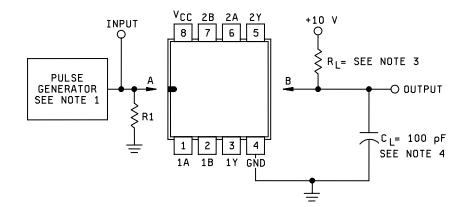
- 1. The pulse generator shall have the following characteristics: PRR = 1 MHz, $t_p = 0.5 \ \mu s$, $Z_{out} \cong 50 \ \Omega$. 2. When testing device 01 or 06, connect output Y to transistor base and ground the substrate terminal.
- 3. $R_L = 47 \Omega \pm 5\%$ carbon.
- 4. C_L = 100 pF minimum, including probe and jig capacitance.
- 5. R1 = 51 $\Omega \pm 5\%$ carbon.

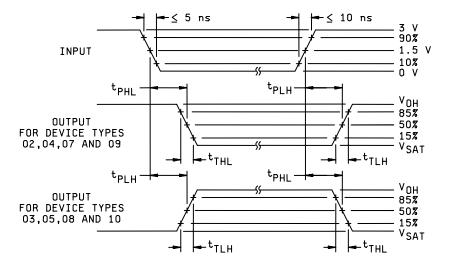
FIGURE 7. Switching time waveforms (TTL gates and transistors combined) for device types 01 and 06.



- 1. The pulse generator shall have the following characteristics: PRR = 1 MHz, t_p = 0.3 µs, $Z_{out} \cong 50 \Omega$.
- 2. $C_L = 100 \text{ pF}$ minimum, including probe and jig capacitance.
- 3. R1 = 62 $\Omega \pm 5\%$ carbon.
- 4. R2 = 1 k $\Omega \pm 5\%$ carbon.
- 5. $C1 = 0.1 \ \mu F \pm 5\%$.
- 6. $R_L = 47 \ \Omega \pm 5\%$ carbon.
- 7. R3 = $51\Omega \pm 5\%$ carbon.
- 8. All voltages have a tolerance of $\pm 1\%$ of nominal.

FIGURE 8. Switching times (transistors only) for device types 01 and 06.





- 1. Pulse generator shall have the following characteristics: PRR \leq 1 MHz, Z_{out} \cong 50 Ω , t_f \leq 10 ns, t_f \leq 5 ns.
- 2. R1 = 51 $\Omega \pm 5\%$.
- 3. $R_L = 47 \ \Omega \pm 5\%$.
- 4. $C_L = 100 \text{ pF} \pm 10\%$, including probe and jig capacitance.

FIGURE 9. Switching time waveforms for device types 02 through 05 and 07 through 10.

TABLE III. Group A inspection for device type 01.

Subgroup	Symbol	Test	1	2	17	12	15	16	4	3	5	8	9	10	11	7	6	Relays ener-		leasure terminal		Equations	Note	Test	limits	Unit
		no.	Vs1	V _{S2}	V _{S3}	1B	1C	1E	2B	2E	2C	Vcc	G	1A	1Y	2A	2Y	gized	No.	Value	Unit			Min	Max	1
1	VIC	1										4.5 V	-12 mA	4.5 V		4.5 V		None	9	E1	V	$V_{IC} = E1$	See		-1.5	V
T _A =	VIC	2										4.5 V	4.5 V	-12 mA		4.5 V		"	10	E2	V	$V_{IC} = E2$	figure 3		-1.5	V
+25°C	VIC	3										4.5 V	4.5 V	4.5 V		-12 mA		"	7	E3	V	$V_{IC} = E3$	for test		-1.5	V
	l _{IH1}	4										5.5 V	GND	2.4 V		GND		"	10	11	А	I _{IH1} = I1	circuit		40	μΑ
	l _{IH1}	5										"	**	GND		2.4 V		**	7	12	"	I _{IH1} = I2	"		40	μA
	liH2	6										"	**	5.5 V		GND		"	10	13	"	I _{IH2} = I3	"		1	mA
	l _{IH2}	7										**	"	GND		5.5 V		"	7	14	"	$I_{IH2} = I4$	"		1	m/
	I _{IH3}	8										**	2.4 V	GND		GND		"	9	15	"	I _{IH3} = 15	"		80	μA
	l _{IH4}	9										"	5.5 V	GND		GND		"	9	16	"	I _{IH4} = 16	"		2	m/
	I _{IL1}	10										"	5.5 V	0.4 V		5.5 V		"	10	17	"	I _{IL1} = 17	"		-1.6	m/
	I _{IL1}	11										**	5.5 V	5.5 V		0.4 V		**	7	18	"	I _{IL1} = 18	"		-1.6	"
	I _{IL2}	12										"	0.4 V	5.5 V		5.5 V		"	9	19	"	$I_{1L2} = 19$	"		-3.2	**
	ICCH1	13										"	GND	GND		GND		"	8	l10	"	ICCH1 = I10	"		4	"
	ICCL1	14										**	5.5 V	5.5 V		5.5 V		"	8	l11	"	ICCL1 = 111	"		11	"
	Vol9	15										4.5 V	2 V	2 V	I _{OL} = 16 mA			"	11	E4	V	V _{OL9} = E4	"		0.5	V
	Vol9	16										**	2 V			2 V	I _{OL} = 16 mA	"	6	E5	"	V _{OL9} = E5	"		0.5	"
	Vон	17										"	4.5 V	0.8 V	IOH = - 400 μA			"	11	E6	"	Voh = E6	"	2.4		"
	Vон	18										**	4.5 V			0.8 V	IOH = - 400 μA	"	6	E7	"	VOH = E7	"	2.4		"
	los1	19										5.5 V	GND	GND	GND			"	11	l12	Α	los1 = 112	"		-55	m
	los1	20										5.5 V	"			GND	GND	"	6	113	**	I _{OS1} = I13	"		-55	m
	IOS2	21										4.5 V	**	GND	GND			"	11	114	"	I _{OS2} = 114		-18		**
	I _{OS2}	22										4.5 V	**			GND	GND	"	6	l15	"	I _{OS2} = 115		-18		"
	h _{FE1}	23	4 V	V 5 2														**	18 to 14	E8	v	hFE1 = E8/1000	See figures 3 and 4	25		
	h _{FE1}	24	4 V	"														3	"	E9	"	h _{FE1} = E9/1000	for test	25		
	h _{FE2}	25	6 V	"														None	"	E10	"	h _{FE2} = E10/3000	circuit	30		
	h _{FE2}	26	6 V	"														3	"	E11	"	h _{FE2} = E11/3000	and waveforms	30		
	V_{BE1}	27	4 V	"	V 5 3													1,2	12 to	E12	"	V _{BE1} = E12	"		1.2	V
	V_{BE1}	28	4 V	u	V S 3													1,2,3	16 11 to 10	E13	"	V _{BE1} = E13	"		1.2	v

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Subgroup	Symbol	Test	1	2	17	12	15	16	4	3	5	8	9	10	11	7	6	Relays ener-		leasure termina		Equations	Note	Test I	imits	Unit
		no.	Vs1	V _{S2}	V _{S3}	1B	1C	1E	2B	2E	2C	Vcc	G	1A	1Y	2A	2Y	gized	No.	Value	Unit			Min	Max	
1 T _A =	V _{BE2}	29	6 V	V S 2	V S 3													1,2	12 to 16	E14	V	V _{BE2} = E14	See figures 3 and 4		1.4	V
+25°C	V _{BE2}	30	6 V	"	"													1,2,3	11 to 10	E15	"	V _{BE2} = E15	for test		1.4	V
	VCESAT 1	31	4 V	**	"													1,2	5 to 6	E16	"	VCESAT1 = E16	circuit		0.5	"
	VCESAT 1	32	4 V	"	"													1,2,3	10 to 9	E17	"	VCESAT1 = E17	and waveforms		0.5	"
	VCESAT 2	33	6 V	"	"													1,2	5 to 6	E18	"	V _{CESAT2} = E18	"		0.8	"
	V _{CESAT}	34	6 V	"	"													1,2,3	10 to 9	E19	"	V _{CESAT2} = E19	u		0.8	"
	V _{CB01}	35				GND	100 μΑ											3	15 to 12	E20	"	V _{CB01} = E20	See figure 3 for test	35		"
	V _{CB01}	36							GND		100 μΑ							4	5 to 3	E21	u	V _{CB01} = E21	circuit	35		"
	V _{CER1}	37					100 μΑ	GND										4	15 to 16	E22	"	V _{CER1} = E22	"	35		"
	V _{CER1}	38								GND	100 μΑ							3,4	5 to 3	E23	"	V _{CER1} = E23	"	35		**
	V _{EBO}	39				GND		100 μΑ										3,4	16 to 12	E24	"	V _{EBO} = E24	"	5		"
	V _{EBO}	40							GND	100 μΑ								4	3 to 4	E25	"	V _{EBO} = E25	"	5		"
2	VIC	41										4.5 V	-12 mA	4.5 V		4.5 V		None	9	E1	V	$V_{IC} = E1$	See		-1.5	V
T _A = +125°C	VIC	42 43										4.5 V 4.5 V	4.5 V 4.5 V	-12 mA 4.5 V		4.5 V -12 mA		"	10 7	E2 E3	V V	$V_{IC} = E2$	figure 3 for test		-1.5 -1.5	V V
+125 0	VIC IIH1	43										4.5 V	GND	4.5 V 2.4 V		GND		u	10	E3 11	A	V _{IC} = E3	circuit		40	ν μA
	liH1	45										"	"	GND		2.4 V		"	7	12	"	$I_{\rm H1} = 12$	"		40	μA
	I _{IH2}	46										"	"	5.5 V		GND		"	10	13	"	I _{IH2} = 13	"		1	mA
	I _{IH2}	47										"	**	GND		5.5 V		"	7	14	"	$I_{1H2} = 14$	"		1	mA
	IIH3	48										"	2.4 V	GND		GND		"	9	15	"	I _{IH3} = 15	"		80	μA
	I _{IH4}	49										"	5.5 V	GND		GND		"	9	16	"	I _{IH4} = 16	"		2	mA
	l _{IL1}	50								1		"	5.5 V	0.4 V		5.5 V		u	10	17	"	I _{IL1} = 17	"		-1.6	mA
	liL1	51										"	5.5 V	5.5 V		0.4 V		"	7	18	"	I _{IL1} = 18	"		-1.6	"
	I _{IL2}	52										"	0.4 V	5.5 V		5.5 V		"	9	19	"	$I_{1L2} = 19$	"		-3.2	"
	ICCH1	53										"	GND	GND		GND		"	8	I10	"	I _{CCH1} = 110	"		4	"
	ICCL1	54										"	5.5 V	5.5 V		5.5 V		"	8	l11	"	I _{CCL1} =	"		11	"

TABLE III. Group A inspection for device type 01 – Continued.

Subgroup	Symbol	Test	1	2	17	12	15	16	4	3	5	8	9	10	11	7	6	Relays ener-	Measu	ired ter	minal	Equations	Note	Test I	mits	Unit
		no.	Vs1	V _{S2}	V _{S3}	1B	1C	1E	2B	2E	2C	Vcc	G	1A	1Y	2A	2Y	gized	No.	Value	Unit			Min	Max	
2	V _{OL9}	55										4.5 V	2 V	2 V	I _{OL} = 16 mA			None	11	E4	V	V _{OL9} = E4	See		0.5	V
T _A =	V _{OL9}	56										"	2 V			2 V	I _{OL} = 16 mA	"	6	E5	"	V _{OL9} = E5	figure 3		0.5	"
+125°C	VOH	57										"	4.5 V	0.8 V	I _{OH} = - 400 μA			"	11	E6	"	V _{OH} = E6	for test	2.4		"
	V _{OH}	58										"	4.5 V			0.8 V	I _{OH} = - 400 μA	"	6	E7	"	V _{OH} = E7	circuit	2.4		"
	I _{OS1}	59										5.5 V	GND	GND	GND		400 μ/	"	11	l12	Α	I _{OS1} = I12	"		-55	mA
	los1	60										5.5 V	"			GND	GND	"	6	l13	"	I _{OS1} = I13	"		-55	"
	los2	61										4.5 V	"	GND	GND			**	11	l14	"	I _{OS2} = 114	"	-18		"
	I _{OS2}	62										4.5 V	"			GND	GND	"	6	l15	"	I _{OS2} = 115	"	-18		"
	h _{FE1}	63	4 V	$V\overline{S} 2$														**	18 to 14	E8	V	h _{FE1} = E8/1000	See figures 3 and 4	25		
	h _{FE1}	64	4 V	"														3	"	E9	"	h _{FE1} = E9/1000	for test	25		
	hFE2	65	6 V	"														None	"	E10	"	hFE2 = E10/3000	circuit	30		
	h _{FE2}	66	6 V	"														3	"	E11	"	h _{FE2} = E11/3000	and waveforms	30		
	V_{BE1}	67	4 V	"	V S 3													1,2	12 to 16	E12	"	V _{BE1} = E12	"		1.2	V
	V_{BE1}	68	4 V	"	V S 3													1,2,3	11 to 10	E13	"	V _{BE1} = E13	"		1.2	V
	V_{BE2}	69	6 V	"	V S 3													1,2	12 to 16	E14	V	V _{BE2} = E14	See figures 3 and 4		1.4	V
	V_{BE2}	70	6 V	**	"													1,2,3	11 to 10	E15	"	V _{BE2} = E15	for test		1.4	V
	VCESAT	71	4 V	"	"													1,2	5 to 6	E16	"	V _{CESAT1} = E16	circuit		0.5	"
	1 V _{CESAT}	72	4 V	"	**													1,2,3	10 to 9	E17	"	V _{CESAT1} = E17	and waveforms		0.5	"
	1 V _{CESAT}	73	6 V	"	**													1,2	5 to 6	E18	"	V _{CESAT2}	"		0.8	"
	2 V _{CESAT}	74	6 V	"	**													1,2,3	10 to	E19	"	= E18 V _{CESAT2}	u		0.8	"
	2		0.															1,2,0	9	2.0		= E19	See figure		0.0	
	V _{CB01}	75				GND	100 μA				100							3	15 to 12	E20	"	V _{CB01} = E20	See figure 3 for test	35		"
	V _{CB01}	76							GND		100 μΑ							4	5 to 3	E21	"	V _{CB01} = E21	circuit	35		u
	VCER1	77					100 μA	GND										4	15 to 16	E22	"	V _{CER1} = E22	"	35		"
	VCER1	78								GND	100 μΑ							3,4	5 to 3	E23	"	V _{CER1} = E23	"	35		"

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 TABLE III.
 Group A inspection for device type 01 – Continued.

Subgroup	Symbol	Test	1	2	17	12	15	16	4	3	5	8	9	10	11	7	6	Relays ener-	Measu	ured terr	ninal	Equations	Note	Test I	imits	Unit
		no.	Vs1	V _{S2}	V _{S3}	1B	1C	1E	2B	2E	2C	Vcc	G	1A	1Y	2A	2Y	gized	No.	Value	Unit			Min	Max	
2 T _A =	V _{EBO}	79				GND		100 μA										3,4	16 to 12	E24	V	V _{EBO} = E24	See figure 3 for test	5		V
+125°C	V_{EBO}	80							GND	100 μΑ								4	3 to 4	E25	"	V _{EBO} = E25	circuit	5		"
3	VIC	81										4.5 V	-12 mA	4.5 V		4.5 V		None	9	E1	V	$V_{IC} = E1$	See		-1.5	V
T _A =	VIC	82										4.5 V	4.5 V	-12 mA		4.5 V		"	10	E2	V	$V_{IC} = E2$	figure 3		-1.5	V
-55°C	VIC	83										4.5 V	4.5 V	4.5 V		-12 mA		"	7	E3	V	$V_{IC} = E3$	for test		-1.5	V
	I _{IH1}	84										5.5 V	GND	2.4 V		GND		**	10	11	Α	I _{IH1} = I1	circuit		40	μA
	I _{IH1}	85										**	**	GND		2.4 V		**	7	12	"	I _{IH1} = I2	**		40	μA
	I _{IH2}	86										"	"	5.5 V		GND		"	10	13	"	I _{IH2} = 13	"		1	mA
	I _{IH2}	87										"	"	GND		5.5 V		"	7	14	"	I _{IH2} = I4			1	mA
	I _{IH3}	88										"	2.4 V	GND		GND		"	9	15	"	I _{IH3} = 15	"		80	μA
	I _{IH4}	89										"	5.5 V	GND		GND		"	9	16	"	I _{IH4} = 16			2	mA
	l _{IL1}	90										"	5.5 V	0.4 V		5.5 V		"	10	17	"	$I_{IL1} = 17$			-1.6	mA "
	l _{IL1}	91 00										"	5.5 V	5.5 V		0.4 V		"	7	18	"	$I_{IL1} = 18$	"		-1.6	"
	I _{IL2}	92											0.4 V	5.5 V		5.5 V			9	19		$I_{1L2} = 19$			-3.2	
	ICCH1	93										"	GND	GND		GND		"	8	I10	"	ICCH1 = 110	"		4	"
	ICCL1	94										"	5.5 V	5.5 V		5.5 V		"	8	l11	"	ICCL1 = 111	"		11	"
	Vol9	95										4.5 V	2 V	2 V	I _{OL} = 16 mA			"	11	E4	V	Vol9 = E4	"		0.5	V
	VOL9	96										"	2 V			2 V	I _{OL} = 16 mA	"	6	E5	"	V _{OL9} = E5	"		0.5	"
	Vон	97										u	4.5 V	0.8 V	I _{OH} = - 400 μA			"	11	E6	"	Vон = E6	"	2.4		"
	Vон	98										"	4.5 V		-100 μ/ i	0.8 V	I _{OH} = - 400 μA	"	6	E7	"	V _{OH} = E7	"	2.4		"
	los1	99										5.5 V	GND	GND	GND		400 μΛ	"	11	l12	А	IOS1 = I12	"		-55	mA
	los1	100										5.5 V	"	_	-	GND	GND	"	6	113	"	$l_{OS1} = 113$	66		-55	mA
	I _{OS2}	101										4.5 V	"	GND	GND			**	11	I14	"	I _{OS2} = 114	"	-18		"
	I _{OS2}	102										4.5 V	"			GND	GND	"	6	l15	"	I _{OS2} = 115	66	-18		"
	h _{FE3}	103	4 V	V \$ 2														"	18 to 14	E8	V	h _{FE3} = E8/1000	See figures 3 and 4	10		
	h _{FE3}	104	4 V	"														3	"	E9	"	h _{FE3} = E9/1000	for test	10		
	h _{FE4}	105	6 V	u														None	"	E10	"	h _{FE4} = E10/3000	circuit	15		
	h _{FE4}	106	6 V	"														3	"	E11	"	h _{FE4} = E11/3000	and waveforms	15		
	V_{BE1}	107	4 V	"	V S 3		L		L							L		1,2	12 to 16	E12	"	V _{BE1} = E12	"		1.2	V
	V_{BE1}	108	4 V	"	V S 3													1,2,3	11 to 10	E13	"	V _{BE1} = E13	"		1.2	v

 TABLE III.
 Group A inspection for device type 01 – Continued.

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Subgroup	Symbol	Test	1	2	17	12	15	16	4	3	5	8	9	10	11	7	6	Relays ener-	Measu	ired terr	minal	Equations	Note	Test I	imits	Unit
		no.	V _{S1}	V _{S2}	V _{S3}	1B	1C	1E	2B	2E	2C	V _{CC}	G	1A	1Y	2A	2Y	gized	No.	Value	Unit			Min	Max	
3	V_{BE2}	109	6 V	V S 2	V S 3													1,2	12 to 16	E14	۷	V _{BE2} = E14	See figures 3 and 4		1.4	V
TA =	VBE2	110	6 V	"	**													1,2,3	11 to 10	E15	ű	V _{BE2} = E15	for test		1.4	V
-55°C	VCESAT	111	4 V	"	"													1,2	5 to 6	E16	ű	VCESAT1 = E16	circuit		0.5	"
	VCESAT	112	4 V	**	**													1,2,3	10 to 9	E17	u	V _{CESAT1} = E17	and waveforms		0.5	"
	VCESAT 2	113	6 V	"	"													1,2	5 to 6	E18	"	VCESAT2 = E18	"		0.8	"
	VCESAT 2	114	6 V	"	"													1,2,3	10 to 9	E19	u	V _{CESAT2} = E19	"		0.8	"
	VCB01	115				GND	100 μA											3	15 to 12	E20	ű	V _{CB01} = E20	See figure 3 for test	35		"
	VCB01	116							GND		100 μΑ							4	5 to 3	E21	ű	V _{CB01} = E21	circuit	35		"
	V _{CER1}	117					100 μA	GND										4	15 to 16	E22	ű	V _{CER1} = E22	"	35		"
	V _{CER1}	118								GND	100 μΑ							3,4	5 to 3	E23	ű	V _{CER1} = E23	"	35		"
	Vebo	119				GND		100 μA										3,4	16 to 12	E24	ű	V _{EBO} = E24	"	5		"
	Vebo	120							GND	100 μΑ								4	3 to 4	E25	ű	V _{EBO} = E25	"	5		"

 TABLE III.
 Group A inspection for device type 01 – Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	9	10	11	12	13	14	Notes	Measured	Test	limits	Unit
		no.	G	1A	1Y	1B	1C	1E	GND	Sub	2E	2C	2B	2Y	2A	V _{CC}		terminal	Min	Max	
9	tD	121				Α	В	GND		GND							See figure 8	5		15	ns
$T_A =$	tD	122								"	GND	В	А				for test	10		"	**
+25°C	ts	123				А	В	GND		"							circuit and	5		"	"
	ts	124								"	GND	В	А				waveforms	10		"	"
	t _R	125				А	В	GND		"							"	5		20	"
	tR	126								"	GND	В	А				"	10		20	"
	tF	127				А	В	GND		"							"	5		15	"
	t _F	128								"	GND	В	А				"	10		15	"
	tPLH1	129	3 V	IN	OUT					"						4.5 V	See figure 6	2 to 3		30	"
	"	130 131	IN 3 V	3 V	OUT					"				OUT	IN	"	for test circuit and	1 to 3 13 to 12		"	"
	"	132	IN							**				OUT	3 V	"	waveforms	1 to 12		"	**
	tPHL1	133	3 V	IN	OUT					"						4.5 V	"	2 to 3		15	**
	"	134	IN	3 V	OUT					"						"	"	1 to 3		"	"
	"	135 136	3 V IN							"				OUT OUT	IN 3 V	"	"	13 to 12 1 to 12		"	"
	tPLH2	137	3 V	IN	Connect		OUT			"				001	5.0	4.5.1	0 <i>finun</i> 7			30	"
	"	137	3 V	IIN	to 1B		001									4.5 V	See figure 7	2 to 5		30	"
	"	138	IN	3 V	Connect to 1B		OUT			"						"	for test	1 to 5		"	**
	"	139	3 V							"		OUT		Connect to 2B	IN	"	circuit and	13 to 10		"	"
	"	140	IN							"		OUT		Connect to 2B	3 V	"	waveforms	1 to 10		u	"
	tPHL2	141	3 V	IN	Connect to 1B		OUT			"						4.5 V	"	2 to 5		30	**
	"	142	IN	3 V	Connect to 1B		OUT			"						"	"	1 to 5		"	**
	"	143	3 V							"		OUT		Connect to 2B		"	"	13 to 10		"	**
	"	144	IN							**		OUT		Connect to 2B		"	"	1 to 10		"	**
	tTLH1	145	3 V	IN	Connect to 1B		OUT			"						"	"	5		15	"
	t _{TLH1}	146	3 V							"		OUT		Connect to 2B	IN	"	"	10		"	"
	tTHL1	147	3 V	IN	Connect to 1B		OUT			**						"	"	5		"	**
	t _{THL1}	148	3 V							"		OUT		Connect to 2B	IN	"	"	10		"	"

 TABLE III.
 Group A inspection for device type 01 – Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	9	10	11	12	13	14	Notes	Measured	Test	limits	Unit
		no.	G	1A	1Y	1B	1C	1E	GND	Sub	2E	2C	2B	2Y	2A	Vcc		terminal	Min	Max	
10	tD	149				Α	В	GND		GND							See figure 8	5		22.5	ns
TA =	tD	150								"	GND	В	А				for test	10		"	"
+125°C	ts	151				Α	В	GND		"							circuit and	5		"	"
	ts	152								"	GND	В	А				waveforms	10		"	"
	t _R	153				Α	В	GND		"							"	5		30	"
	t _R	154								"	GND	В	А				"	10		30	"
	tF	155				А	В	GND		"							"	5		22.5	**
	tF	156								"	GND	В	Α				"	10		22.5	"
	tPLH1	157	3 V	IN	OUT					"						4.5 V "	See figure 6	2 to 3		45 "	"
	"	158 159	IN 3 V	3 V	OUT					"				OUT	IN	"	for test circuit and	1 to 3 13 to 12		"	"
	"	160	IN							"				OUT	3 V	"	waveforms	1 to 12		"	"
	tPHL1	161	3 V	IN	OUT					"						4.5 V	"	2 to 3		22.5	"
	"	162	IN	3 V	OUT					"				0.UT		"	"	1 to 3		"	"
	"	163 164	3 V IN							"				OUT OUT	IN 3 V	"	"	13 to 12 1 to 12		"	"
	t _{PLH2}	165	3 V	IN	Connect to 1B		OUT			"				001		4.5 V	See figure 7	2 to 5		45	"
	"				Connect					"						**				"	**
		166	IN	3 V	to 1B		OUT										for test	1 to 5			
	"	167	3 V							"		OUT		Connect to 2B	IN	**	circuit and	13 to 10		"	"
	"	168	IN							"		OUT		Connect to 2B	3 V	"	waveforms	1 to 10		"	**
	tPHL2	169	3 V	IN	Connect to 1B		OUT			"						4.5 V	"	2 to 5		"	"
	"	170	IN	3 V	Connect to 1B		OUT			"						**	"	1 to 5		"	**
	"	171	3 V							"		OUT		Connect to 2B		**	"	13 to 10		"	"
	"	172	IN							"		OUT		Connect to 2B		**	"	1 to 10		"	"
	ttlH1	173	3 V	IN	Connect to 1B		OUT			"						**	"	5		22.5	"
	tTLH1	174	3 V							"		OUT		Connect to 2B	IN	**	"	10		"	"
	t _{THL1}	175	3 V	IN	Connect to 1B		OUT			"						**	"	5		"	"
	tTHL1	176	3 V							"		OUT		Connect to 2B	IN	**	u	10		"	"

 TABLE III.
 Group A inspection for device type 01 – Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	9	10	11	12	13	14	Notes	Measured	Test	limits	Unit
		no.	G	1A	1Y	1B	1C	1E	GND	Sub	2E	2C	2B	2Y	2A	Vcc		terminal	Min	Max	
11	tD	177				А	В	GND		GND							See figure 8	5		22.5	ns
TA =	tD	178								"	GND	В	А				for test	10		"	"
-55°C	ts	179				А	В	GND		**							circuit and	5		"	"
	ts	180								"	GND	В	А				waveforms	10		"	"
	t _R	181				A	В	GND		"		_					"	5		30	"
	t _R	182								"	GND	В	A				"	10		30	"
	tF	183				A	В	GND		"	GND	P					"	5		22.5 22.5	"
	tF	184	3 V	IN	OUT					"	GND	В	A			4514	O a a firmura C	10 2 to 3		-	"
	tPLH1 "	185 186	3 V IN	IN 3 V	OUT					"						4.5 V "	See figure 6 for test	2 to 3 1 to 3		45 "	"
	"	187	3 V	0.	001					"				OUT	IN	"	circuit and	13 to 12		"	"
	"	188	IN							"				OUT	3 V	"	waveforms	1 to 12		"	"
	tPHL1	189 190	3 V IN	IN 3 V	OUT OUT					"						4.5 V "	"	2 to 3 1 to 3		22.5	"
	"	190	3 V	3 V	001					"				OUT	IN	"	**	13 to 12		"	"
	"	192	IN							"				OUT	3 V	"	**	1 to 12		"	"
	tPLH2	193	3 V	IN	Connect to 1B		OUT			"						4.5 V	See figure 7	2 to 5		45	"
	"	194	IN	3 V	Connect to 1B		OUT			"						"	for test	1 to 5		"	"
	"	195	3 V							"		OUT		Connect to 2B	IN	"	circuit and	13 to 10		"	**
	"	196	IN							**		OUT		Connect to 2B	3 V	"	waveforms	1 to 10		"	"
	tPHL2	197	3 V	IN	Connect to 1B		OUT			"						4.5 V	"	2 to 5		"	"
	"	198	IN	3 V	Connect to 1B		OUT			"						"	"	1 to 5		"	"
	"	199	3 V							"		OUT		Connect to 2B		"	"	13 to 10		"	"
	"	200	IN							**		OUT		Connect to 2B		"	"	1 to 10		"	"
	tTLH1	201	3 V	IN	Connect to 1B		OUT			"						"	"	5		22.5	"
	ttlH1	202	3 V							**		OUT		Connect to 2B	IN	"	"	10		"	"
	tTHL1	203	3 V	IN	Connect to 1B		OUT			**						"	"	5		"	"
	t⊤HL1	204	3 V							"		OUT		Connect to 2B	IN	"	"	10		u	"

 TABLE III.
 Group A inspection for device type 01 – Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	Vcc		terminal	Min	Max	
1	VIC	1	-12 mA	4.5 V		GND				4.5 V	See figure	1 to 4		-1.5	V
TA =	"	2	4.5 V	-12 mA		**				"	5 for test	2 to 4		"	"
+25°C	"	3				"		-12 mA	4.5 V	"	circuit	6 to 4		"	"
	"	4				**		4.5 V	-12 mA	"	"	7 to 4		"	"
	l _{IH1}	5	2.4 V	GND		"				5.5 V	"	1 to 4		40	μA
	"	6	GND	2.4 V		"				"	"	2 to 4		"	"
	"	7				66		2.4 V	GND	"	"	6 to 4		"	"
	"	8				**		GND	2.4 V	"	"	7 to 4		"	"
	lih2	9	5.5 V	GND		"				66	"	1 to 4		1	mA
	"	10	GND	5.5 V		"				"	"	2 to 4		"	"
	"	11				66		5.5 V	GND	66	"	6 to 4		"	"
	"	12				66		GND	5.5 V	"	"	7 to 4		"	"
	l _{IL1}	13	0.4 V	5.5 V		"				"	"	1 to 4		-1.6	mA
	**	14	5.5 V	0.4 V		"				"	"	2 to 4		"	"
	"	15				66		0.4 V	5.5 V	"	"	6 to 4		"	"
	**	16				"		5.5 V	0.4 V	"	"	7 to 4		"	"
	I _{CCH2}	17	5.5 V	5.5 V		66		5.5 V	5.5 V	"	"	8		11	"
	ICCL2	18	GND	GND		66		GND	GND	**	"	8		65	"
	V _{OL1}	19	0.8 V	0.8 V	100 mA	"				4.5 V	"	3 to 4		0.5	V
	V _{OL1}	20				66	100 mA	0.8 V	0.8 V	**	"	5 to 4		0.5	"
	V _{OL5}	21	0.8 V	0.8 V	300 mA	"				"	"	3 to 4		0.8	"
	V _{OL5}	22				66	300 mA	0.8 V	0.8 V	"	"	5 to 4		0.8	"
	I _{OH1}	23	2 V	2 V	30 V	66				"	"	3		300	μΑ
	IOH1	24				**	30 V	2 V	2 V	"	"	5		300	"

TABLE III. Group A inspection for device type 02.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	Vcc		terminal	Min	Max	
2	VIC	25	-12 mA	4.5 V		GND				4.5 V	See figure	1 to 4		-1.5	V
T _A =	"	26	4.5 V	-12 mA		"				"	5 for test	2 to 4		"	"
+125°C	"	27				"		-12 mA	4.5 V	u	circuit	6 to 4		"	"
	"	28				"		4.5 V	-12 mA	"	65	7 to 4		"	"
	I _{IH1}	29	2.4 V	GND		"				5.5 V	66	1 to 4		40	μΑ
	"	30	GND	2.4 V		"				u	**	2 to 4		"	"
	"	31				"		2.4 V	GND	"	66	6 to 4		"	"
	"	32				"		GND	2.4 V	u	**	7 to 4		"	"
	I _{IH2}	33	5.5 V	GND		"				u	"	1 to 4		1	mA
	"	34	GND	5.5 V		"				u	££	2 to 4		"	"
	"	35				"		5.5 V	GND	u	**	6 to 4		"	"
	"	36				"		GND	5.5 V	u	**	7 to 4		"	"
	l _{IL1}	37	0.4 V	5.5 V		"				"	66	1 to 4		-1.6	mA
	"	38	5.5 V	0.4 V		"				"	66	2 to 4		"	"
	"	39				"		0.4 V	5.5 V	u	££	6 to 4		"	"
	"	40				"		5.5 V	0.4 V	"	66	7 to 4		"	"
	I _{CCH2}	41	5.5 V	5.5 V		"		5.5 V	5.5 V	"	**	8		11	"
	ICCL2	42	GND	GND		"		GND	GND	u	££	8		65	"
	V _{OL1}	43	0.8 V	0.8 V	100 mA	"				4.5 V	££	3 to 4		0.5	V
	V _{OL1}	44				"	100 mA	0.8 V	0.8 V	"	66	5 to 4		0.5	"
	V _{OL5}	45	0.8 V	0.8 V	300 mA	"				u	"	3 to 4		0.8	"
	V _{OL5}	46				"	300 mA	0.8 V	0.8 V	"	66	5 to 4		0.8	"
	I _{OH1}	47	2 V	2 V	30 V	"				"	66	3		300	μΑ
	IOH1	48				"	30 V	2 V	2 V	"	55	5		300	"

 TABLE III.
 Group A inspection for device type 02
 Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	Vcc		terminal	Min	Max	
3	VIC	49	-12 mA	4.5 V		GND				4.5 V	See figure	1 to 4		-1.5	V
T _A =	"	50	4.5 V	-12 mA		"				"	5 for test	2 to 4		"	"
-55°C	"	51				"		-12 mA	4.5 V	"	circuit	6 to 4		"	"
	"	52				"		4.5 V	-12 mA	"	"	7 to 4		"	"
	I _{IH1}	53	2.4 V	GND		"				5.5 V	"	1 to 4		40	μΑ
	"	54	GND	2.4 V		"				"	"	2 to 4		"	"
	"	55				"		2.4 V	GND	"	"	6 to 4		"	"
	"	56				"		GND	2.4 V	"	"	7 to 4		"	"
	I _{IH2}	57	5.5 V	GND		"				"	"	1 to 4		1	mA
	"	58	GND	5.5 V		"				"	"	2 to 4		"	"
	"	59				"		5.5 V	GND	"	"	6 to 4		"	"
	"	60				"		GND	5.5 V	"	"	7 to 4		"	"
	l _{IL1}	61	0.4 V	5.5 V		"				"	"	1 to 4		-1.6	mA
	"	62	5.5 V	0.4 V		"				"	"	2 to 4		"	"
	"	63				"		0.4 V	5.5 V	"	"	6 to 4		"	"
	"	64				"		5.5 V	0.4 V	"	"	7 to 4		"	"
	I _{CCH2}	65	5.5 V	5.5 V		"		5.5 V	5.5 V	"	"	8		11	"
	ICCL2	66	GND	GND		"		GND	GND	"	"	8		65	"
	V _{OL1}	67	0.8 V	0.8 V	100 mA	"				4.5 V	"	3 to 4		0.5	V
	V _{OL1}	68				"	100 mA	0.8 V	0.8 V	"	"	5 to 4		0.5	"
	Vol5	69	0.8 V	0.8 V	300 mA	"				"	"	3 to 4		0.8	"
	V _{OL5}	70				"	300 mA	0.8 V	0.8 V	"	"	5 to 4		0.8	"
	IOH1	71	2 V	2 V	30 V	"				"	"	3		300	μA
	IOH1	72				"	30 V	2 V	2 V	"	ű	5		300	"

 TABLE III.
 Group A inspection for device type 02
 Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	V _{CC}		terminal	Min	Max	
9	tPLH	73	IN	3 V	OUT	GND				4.5 V	See figure 9	1 to 3		30	ns
T _A =	"	74	3 V	IN	OUT	"				"	for test	2 to 3		"	"
+25°C	"	75				"	OUT	IN	3 V	"	circuit and	6 to 5		"	"
	"	76				"	OUT	3 V	IN	"	waveforms	7 to 5		"	"
	tPHL	77	IN	3 V	OUT	**				4.5 V	"	1 to 3		30	"
	"	78	3 V	IN	OUT	"				"	**	2 to 3		"	"
	"	79				"	OUT	IN	3 V	"	"	6 to 5		"	"
	"	80				"	OUT	3 V	IN	"	"	7 to 5		"	"
	t _{TLH}	81	IN	IN	OUT	**				"	"	3		14	"
	t _{TLH}	82				"	OUT	IN	IN	"	"	5		14	"
	t THL	83	IN	IN	OUT	**				"	"	3		20	"
	t _{THL}	84				"	OUT	IN	IN	"	**	5		20	"
10	t _{PLH}	85	IN	3 V	OUT	GND				4.5 V	"	1 to 3		45	ns
T _A =	"	86	3 V	IN	OUT	"				"	"	2 to 3		"	**
+125°C	"	87				"	OUT	IN	3 V	"	**	6 to 5		"	**
	"	88				"	OUT	3 V	IN	"	"	7 to 5		"	**
	tPHL	89	IN	3 V	OUT	**				4.5 V	"	1 to 3		"	**
	"	90	3 V	IN	OUT	"				"	**	2 to 3		"	**
	"	91				"	OUT	IN	3 V	"	"	6 to 5		"	"
	"	92				"	OUT	3 V	IN	"	"	7 to 5		"	"
	t _{TLH}	93	IN	IN	OUT	**				"	"	3		18.5	"
	t _{TLH}	94				"	OUT	IN	IN	"	**	5		18.5	"
	t THL	95	IN	IN	OUT	"				"	"	3		25	"
	t _{THL}	96				"	OUT	IN	IN	"	**	5		25	"

TABLE III. Group A inspection for device type 02 - Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	Vcc		terminal	Min	Max	
11	tPLH	97	IN	3 V	OUT	GND				4.5 V	See figure 9	1 to 3		45	ns
T _A =	"	98	3 V	IN	OUT	"				"	for test	2 to 3		"	66
-55°C	"	99				"	OUT	IN	3 V	"	circuit and	6 to 5		"	**
	"	100				"	OUT	3 V	IN	"	waveforms	7 to 5		"	**
	tPHL	101	IN	3 V	OUT	"				4.5 V	"	1 to 3		"	"
	"	102	3 V	IN	OUT	"				"	"	2 to 3		"	**
	"	103				"	OUT	IN	3 V	"	"	6 to 5		"	**
	"	104				"	OUT	3 V	IN	"	"	7 to 5		"	**
	t TLH	105	IN	IN	OUT	"				"	"	3		18.5	"
	t _{TLH}	106				"	OUT	IN	IN	"	"	5		18.5	66
	t _{THL}	107	IN	IN	OUT	"				"	"	3		25	**
	t THL	108				"	OUT	IN	IN	"	"	5		25	"

 TABLE III.
 Group A inspection for device type 02
 Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	Vcc		terminal	Min	Max	
1	VIC	1	-12 mA	4.5 V		GND				4.5 V	See figure	1 to 4		-1.5	V
T _A =	"	2	4.5 V	-12 mA		**				"	5 for test	2 to 4		"	"
+25°C	"	3				"		-12 mA	4.5 V	"	circuit	6 to 4		"	"
	**	4				"		4.5 V	-12 mA	"	"	7 to 4		"	"
	l _{IH1}	5	2.4 V	GND		"				5.5 V	"	1 to 4		40	μA
	"	6	GND	2.4 V		"				"	"	2 to 4		"	"
	"	7				"		2.4 V	GND	"	"	6 to 4		"	"
	"	8				"		GND	2.4 V	"	"	7 to 4		"	"
	I _{IH2}	9	5.5 V	GND		"				"	"	1 to 4		1	mA
	"	10	GND	5.5 V		"				"	"	2 to 4		"	"
	"	11				"		5.5 V	GND	"	"	6 to 4		"	"
	**	12				"		GND	5.5 V	ű	"	7 to 4		"	"
	l _{IL1}	13	0.4 V	5.5 V		"				"	"	1 to 4		-1.6	mA
	**	14	5.5 V	0.4 V		"				ű	"	2 to 4		"	"
	"	15				"		0.4 V	5.5 V	ű	"	6 to 4		"	"
	**	16				"		5.5 V	0.4 V	"	"	7 to 4		"	"
	I _{CCH4}	17	GND	GND		"		GND	GND	"	"	8		14	"
	ICCL4	18	5.5 V	5.5 V		"		5.5 V	5.5 V	"	"	8		71	"
	V _{OL2}	19	2 V	2 V	100 mA	"				4.5 V	"	3 to 4		0.5	V
	V _{OL2}	20				"	100 mA	2 V	2 V	"	"	5 to 4		0.5	"
	Vol6	21	2 V	2 V	300 mA	"				"	"	3 to 4		0.8	"
	V _{OL6}	22				"	300 mA	2 V	2 V	"	"	5 to 4		0.8	"
	I _{OH2}	23	0.8 V	4.5 V	30 V	"				"	"	3		300	μA
	IOH2	24				**	30 V	0.8 V	4.5 V	"	"	5		300	"

TABLE III. Group A inspection for device type 03.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test limits		Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	Vcc		terminal	Min	Max	
2	VIC	25	-12 mA	4.5 V		GND				4.5 V	See figure	1 to 4		-1.5	V
TA =	"	26	4.5 V	-12 mA		**				"	5 for test	2 to 4		"	"
+125°C	"	27				**		-12 mA	4.5 V	"	circuit	6 to 4		"	"
	"	28				66		4.5 V	-12 mA	"	66	7 to 4		"	"
	I _{IH1}	29	2.4 V	GND		"				5.5 V	66	1 to 4		40	μA
	"	30	GND	2.4 V		"				u	66	2 to 4		"	"
	"	31				66		2.4 V	GND	"	66	6 to 4		"	"
	"	32				**		GND	2.4 V	u	66	7 to 4		"	"
	I _{IH2}	33	5.5 V	GND		"				"	"	1 to 4		1	mA
	"	34	GND	5.5 V		"				"	66	2 to 4		"	"
	"	35				**		5.5 V	GND	"	66	6 to 4		"	"
	"	36				**		GND	5.5 V	u	66	7 to 4		"	"
	l _{IL1}	37	0.4 V	5.5 V		66				"	66	1 to 4		-1.6	mA
	"	38	5.5 V	0.4 V		"				"	66	2 to 4		"	"
	"	39				66		0.4 V	5.5 V	"	66	6 to 4		"	"
	"	40				"		5.5 V	0.4 V	"	65	7 to 4		"	"
	I _{CCH4}	41	GND	GND		66		GND	GND	"	66	8		14	"
	ICCL4	42	5.5 V	5.5 V		66		5.5 V	5.5 V	"	66	8		71	"
	V _{OL2}	43	2 V	2 V	100 mA	"				4.5 V	"	3 to 4		0.5	V
	V _{OL2}	44				"	100 mA	2 V	2 V	"	65	5 to 4		0.5	"
	Vol6	45	2 V	2 V	300 mA	"				"	66	3 to 4		0.8	"
	V _{OL6}	46				"	300 mA	2 V	2 V	"	65	5 to 4		0.8	"
	I _{OH2}	47	0.8 V	4.5 V	30 V	"				"	66	3		300	μΑ
	IOH2	48				**	30 V	0.8 V	4.5 V	u	66	5		300	"

 TABLE III.
 Group A inspection for device type 03 – Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	V _{CC}		terminal	Min	Max	
3	VIC	49	-12 mA	4.5 V		GND				4.5 V	See figure	1 to 4		-1.5	V
T _A =	"	50	4.5 V	-12 mA		**				u	5 for test	2 to 4		"	"
-55°C	"	51				66		-12 mA	4.5 V	"	circuit	6 to 4		"	"
	"	52				**		4.5 V	-12 mA	"	"	7 to 4		"	"
	liH1	53	2.4 V	GND		"				5.5 V	**	1 to 4		40	μA
	"	54	GND	2.4 V		"				"	"	2 to 4		"	"
	"	55				**		2.4 V	GND	"	**	6 to 4		"	"
	"	56				**		GND	2.4 V	"	**	7 to 4		"	"
	I _{IH2}	57	5.5 V	GND		"				"	"	1 to 4		1	mA
	"	58	GND	5.5 V		"				"	**	2 to 4		"	"
	"	59				"		5.5 V	GND	"	"	6 to 4		"	"
	"	60				**		GND	5.5 V	"	**	7 to 4		"	"
	l _{IL1}	61	0.4 V	5.5 V		**				"	"	1 to 4		-1.6	mA
	"	62	5.5 V	0.4 V		"				"	**	2 to 4		"	"
	"	63				**		0.4 V	5.5 V	"	"	6 to 4		"	"
	"	64				**		5.5 V	0.4 V	"	**	7 to 4		"	"
	ICCH4	65	GND	GND		**		GND	GND	"	"	8		14	"
	I _{CCL4}	66	5.5 V	5.5 V		**		5.5 V	5.5 V	"	"	8		71	"
	V _{OL2}	67	2 V	2 V	100 mA	"				4.5 V	"	3 to 4		0.5	V
	VOL2	68				**	100 mA	2 V	2 V	"	**	5 to 4		0.5	"
	V _{OL6}	69	2 V	2 V	300 mA	"				"	**	3 to 4		0.8	"
	V _{OL6}	70				**	300 mA	2 V	2 V	"	"	5 to 4		0.8	"
	IOH2	71	0.8 V	4.5 V	30 V	"				"	"	3		300	μA
	I _{OH2}	72				66	30 V	0.8 V	4.5 V	u	"	5		300	"

TABLE III. <u>Group A inspection for device type 03</u> – Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	Vcc		terminal	Min	Max	
9	tPLH	73	IN	3 V	OUT	GND				4.5 V	See figure 9	1 to 3		35	ns
T _A =	"	74	3 V	IN	OUT	"				"	for test	2 to 3		"	"
+25°C	"	75				"	OUT	IN	3 V	"	circuit and	6 to 5		"	**
	"	76				"	OUT	3 V	IN	"	waveforms	7 to 5		"	"
	tPHL	77	IN	3 V	OUT	"				4.5 V	"	1 to 3		35	"
	"	78	3 V	IN	OUT	"				"	"	2 to 3		"	**
	"	79				"	OUT	IN	3 V	"	"	6 to 5		"	"
	"	80				"	OUT	3 V	IN	"	"	7 to 5		"	**
	t TLH	81	IN	IN	OUT	"				"	"	3		14	**
	t _{TLH}	82				"	OUT	IN	IN	"	"	5		14	**
	t _{THL}	83	IN	IN	OUT	"				"	"	3		20	**
	t THL	84				"	OUT	IN	IN	"	££	5		20	**
10	tPLH	85	IN	3 V	OUT	GND				4.5 V	66	1 to 3		55	ns
T _A =	"	86	3 V	IN	OUT	"				"	"	2 to 3		"	"
+125°C	"	87				"	OUT	IN	3 V	"	"	6 to 5		"	"
	"	88				"	OUT	3 V	IN	"	"	7 to 5		"	"
	tPHL	89	IN	3 V	OUT	"				4.5 V	"	1 to 3		55	"
	"	90	3 V	IN	OUT	ű				"	"	2 to 3		"	"
	"	91				"	OUT	IN	3 V	"	"	6 to 5		"	"
	"	92				"	OUT	3 V	IN	"	"	7 to 5		"	**
	ttlh	93	IN	IN	OUT	"				"	"	3		18.5	"
	t _{TLH}	94				"	OUT	IN	IN	"	"	5		18.5	"
	t _{THL}	95	IN	IN	OUT	"				"	"	3		25	"
	t THL	96				"	OUT	IN	IN	"	"	5		25	"

TABLE III. Group A inspection for device type 03 – Continue	TABLE III.	Group A inspection	for device type	03 - Continued
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Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	Vcc		terminal	Min	Max	
11	tPLH	97	IN	3 V	OUT	GND				4.5 V	See figure 9	1 to 3		55	ns
TA =	"	98	3 V	IN	OUT	"				"	for test	2 to 3		"	"
-55°C	"	99				"	OUT	IN	3 V	"	circuit and	6 to 5		"	"
	"	100				"	OUT	3 V	IN	"	waveforms	7 to 5		"	"
	tPHL	101	IN	3 V	OUT	**				4.5 V	"	1 to 3		"	"
	"	102	3 V	IN	OUT	**				"	"	2 to 3		"	"
	"	103				"	OUT	IN	3 V	"	"	6 to 5		"	"
	"	104				"	OUT	3 V	IN	"	"	7 to 5		"	"
	t TLH	105	IN	IN	OUT	**				"	"	3		18.5	"
	t _{TLH}	106				"	OUT	IN	IN	"	"	5		18.5	"
	t _{THL}	107	IN	IN	OUT	**				"	"	3		25	**
	t _{THL}	108				"	OUT	IN	IN	"	"	5		25	"

 TABLE III.
 Group A inspection for device type 03 – Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	V _{CC}		terminal	Min	Max	
1	VIC	1	-12 mA	4.5 V		GND				4.5 V	See figure	1 to 4		-1.5	V
T _A =	"	2	4.5 V	-12 mA		"				"	5 for test	2 to 4		"	"
+25°C	"	3				"		-12 mA	4.5 V	"	circuit	6 to 4		"	"
	"	4				"		4.5 V	-12 mA	"	"	7 to 4		"	"
	liH1	5	2.4 V	GND		"				5.5 V	"	1 to 4		40	μA
	"	6	GND	2.4 V		"				"	"	2 to 4		"	"
	"	7				"		2.4 V	GND	"	"	6 to 4		"	"
	"	8				"		GND	2.4 V	"	"	7 to 4		"	"
	I _{IH2}	9	5.5 V	GND		"				**	"	1 to 4		1	mA
	"	10	GND	5.5 V		"				"	"	2 to 4		"	**
	"	11				"		5.5 V	GND	"	"	6 to 4		"	"
	"	12				**		GND	5.5 V	"	"	7 to 4		"	**
	I _{IL1}	13	0.4 V	GND		"				**	"	1 to 4		-1.6	mA
	"	14	GND	0.4 V		"				**	"	2 to 4		"	**
	"	15				**		0.4 V	GND	**	"	6 to 4		"	**
	"	16				"		GND	0.4 V	"	"	7 to 4		"	**
	ICCH2	17	5.5 V	5.5 V		**		5.5 V	5.5 V	"	"	8		11	**
	I _{CCL3}	18	GND	GND		**		GND	GND	"	"	8		68	**
	V _{OL3}	19	0.8 V	0.8 V	100 mA	"				4.5 V	"	3 to 4		0.5	V
	V _{OL3}	20				"	100 mA	0.8 V	0.8 V	"	"	5 to 4		0.5	**
	V _{OL7}	21	0.8 V	0.8 V	300 mA	"				"	"	3 to 4		0.8	"
	V _{OL7}	22				**	300 mA	0.8 V	0.8 V	**	"	5 to 4		0.8	**
	ЮНЗ	23	2 V	GND	30 V	"				**	"	3		300	μA
	I _{OH3}	24				"	30 V	2 V	GND	"	"	5		300	**

TABLE III. Group A inspection for device type 04.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	Vcc		terminal	Min	Max	
2	VIC	25	-12 mA	4.5 V		GND				4.5 V	See figure	1 to 4		-1.5	V
TA =	"	26	4.5 V	-12 mA		**				"	5 for test	2 to 4		"	"
+125°C	"	27				**		-12 mA	4.5 V	"	circuit	6 to 4		"	"
	"	28				66		4.5 V	-12 mA	"	66	7 to 4		"	"
	l _{IH1}	29	2.4 V	GND		"				5.5 V	66	1 to 4		40	μA
	"	30	GND	2.4 V		"				"	66	2 to 4		"	"
	"	31				66		2.4 V	GND	"	66	6 to 4		"	"
	"	32				**		GND	2.4 V	"	66	7 to 4		"	"
	l _{IH2}	33	5.5 V	GND		"				"	"	1 to 4		1	mA
	"	34	GND	5.5 V		"				"	66	2 to 4		"	"
	"	35				**		5.5 V	GND	"	66	6 to 4		"	"
	"	36				**		GND	5.5 V	"	66	7 to 4		"	"
	I _{IL1}	37	0.4 V	GND		"				"	66	1 to 4		-1.6	mA
	"	38	GND	0.4 V		"				ű	66	2 to 4		"	"
	"	39				66		0.4 V	GND	"	66	6 to 4		"	"
	"	40				"		GND	0.4 V	"	65	7 to 4		"	"
	I _{CCH2}	41	5.5 V	5.5 V		66		5.5 V	5.5 V	ű	66	8		11	"
	ICCL3	42	GND	GND		66		GND	GND	"	66	8		65	"
	V _{OL3}	43	0.8 V	0.8 V	100 mA	"				4.5 V	"	3 to 4		0.5	V
	V _{OL3}	44				"	100 mA	0.8 V	0.8 V	"	65	5 to 4		0.5	"
	VOL7	45	0.8 V	0.8 V	300 mA	"				"	66	3 to 4		0.8	"
	V _{OL7}	46				"	300 mA	0.8 V	0.8 V	"	65	5 to 4		0.8	"
	I _{OH3}	47	2 V	GND	30 V	"				"	66	3		300	μΑ
	ЮНЗ	48				66	30 V	2 V	GND	"	**	5		300	"

 TABLE III.
 Group A inspection for device type 04 – Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	V _{CC}		terminal	Min	Max	
3	VIC	49	-12 mA	4.5 V		GND				4.5 V	See figure	1 to 4		-1.5	V
T _A =	"	50	4.5 V	-12 mA		"				"	5 for test	2 to 4		"	"
-55°C	"	51				**		-12 mA	4.5 V	"	circuit	6 to 4		"	"
	"	52				**		4.5 V	-12 mA	"	66	7 to 4		"	"
	liH1	53	2.4 V	GND		"				5.5 V	**	1 to 4		40	μA
	"	54	GND	2.4 V		"				"	"	2 to 4		"	"
	"	55				**		2.4 V	GND	"	"	6 to 4		"	"
	**	56				**		GND	2.4 V	"	**	7 to 4		"	"
	I _{IH2}	57	5.5 V	GND		"				"	"	1 to 4		1	mA
	**	58	GND	5.5 V		"				"	**	2 to 4		"	"
	"	59				"		5.5 V	GND	"	"	6 to 4		"	"
	**	60				"		GND	5.5 V	"	**	7 to 4		"	"
	I _{IL1}	61	0.4 V	GND		"				"	"	1 to 4		-1.6	mA
	"	62	GND	0.4 V		"				"	"	2 to 4		"	"
	**	63				"		0.4 V	GND	"	**	6 to 4		"	"
	**	64				"		GND	0.4 V	"	**	7 to 4		"	"
	ICCH2	65	5.5 V	5.5 V		"		5.5 V	5.5 V	"	"	8		11	"
	I _{CCL3}	66	GND	GND		**		GND	GND	"	"	8		65	"
	V _{OL3}	67	0.8 V	0.8 V	100 mA	"				4.5 V	"	3 to 4		0.5	V
	VOL3	68				"	100 mA	0.8 V	0.8 V	"	**	5 to 4		0.5	"
	V _{OL7}	69	0.8 V	0.8 V	300 mA	"				u	"	3 to 4		0.8	"
	V _{OL7}	70				**	300 mA	0.8 V	0.8 V	"	**	5 to 4		0.8	"
	ЮНЗ	71	2 V	GND	30 V	"				"	"	3		300	μA
	ЮНЗ	72				"	30 V	2 V	GND	"	**	5		300	"

TABLE III. <u>Group A inspection for device type 04</u> – Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	V _{CC}		terminal	Min	Max	
9	t _{PLH}	73	IN	GND	OUT	GND				4.5 V	See figure 9	1 to 3		30	ns
T _A =	"	74	GND	IN	OUT	"				"	for test	2 to 3		"	"
+25°C	"	75				"	OUT	IN	GND	"	circuit and	6 to 5		**	"
	"	76				"	OUT	GND	IN	"	waveforms	7 to 5		**	"
	t _{PHL}	77	IN	GND	OUT	"				4.5 V	"	1 to 3		30	"
	"	78	GND	IN	OUT	"				"	£6	2 to 3		**	"
	"	79				"	OUT	IN	GND	"	"	6 to 5		**	"
	"	80				"	OUT	GND	IN	"	"	7 to 5		**	"
	t _{TLH}	81	IN	IN	OUT	"				"	"	3		14	"
	t _{TLH}	82				"	OUT	IN	IN	"	"	5		14	"
	t _{THL}	83	IN	IN	OUT	"				"	"	3		20	"
	t _{THL}	84				"	OUT	IN	IN	"	"	5		20	"
10	tPLH	85	IN	GND	OUT	GND				4.5 V	"	1 to 3		45	ns
TA =	"	86	GND	IN	OUT	"				"	"	2 to 3		"	"
+125°C	"	87				"	OUT	IN	GND	"	"	6 to 5		**	"
	"	88				"	OUT	GND	IN	"	"	7 to 5		"	"
	tPHL	89	IN	GND	OUT	"				4.5 V	"	1 to 3		45	"
	"	90	GND	IN	OUT	"				"	"	2 to 3		"	"
	"	91				"	OUT	IN	GND	"	"	6 to 5		"	"
	"	92				"	OUT	GND	IN	"	"	7 to 5		"	"
	t _{TLH}	93	IN	IN	OUT	"				"	66	3		18.5	"
	t _{TLH}	94				"	OUT	IN	IN	"	"	5		18.5	"
	t _{THL}	95	IN	IN	OUT	"				"	"	3		25	"
	t _{THL}	96				"	OUT	IN	IN	"	"	5		25	"

 TABLE III.
 Group A inspection for device type 04 – Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	Vcc		terminal	Min	Max	
11	tPLH	97	IN	GND	OUT	GND				4.5 V	See figure 9	1 to 3		45	ns
TA =	"	98	GND	IN	OUT	"				"	for test	2 to 3		"	"
-55°C	"	99				"	OUT	IN	GND	"	circuit and	6 to 5		"	"
	"	100				"	OUT	GND	IN	"	waveforms	7 to 5		"	"
	tPHL	101	IN	GND	OUT	**				4.5 V	"	1 to 3		"	"
	"	102	GND	IN	OUT	**				"	"	2 to 3		"	"
	"	103				"	OUT	IN	GND	"	"	6 to 5		"	"
	"	104				"	OUT	GND	IN	"	"	7 to 5		"	"
	t TLH	105	IN	IN	OUT	**				"	"	3		18.5	"
	t _{TLH}	106				"	OUT	IN	IN	"	"	5		18.5	"
	t _{THL}	107	IN	IN	OUT	**				"	"	3		25	"
	t THL	108				"	OUT	IN	IN	"	"	5		25	"

TABLE III. Group A inspection for device type 04 - Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	Vcc		terminal	Min	Max	
1	VIC	1	-12 mA	4.5 V		GND				4.5 V	See figure	1 to 4		-1.5	V
TA =	"	2	4.5 V	-12 mA		**				"	5 for test	2 to 4		"	**
+25°C	"	3				**		-12 mA	4.5 V	**	circuit	6 to 4		"	**
	"	4				66		4.5 V	-12 mA	"	66	7 to 4		"	66
	I _{IH1}	5	2.4 V	GND		"				5.5 V	**	1 to 4		40	μA
	"	6	GND	2.4 V		"				"	"	2 to 4		"	**
	"	7				**		2.4 V	GND	"	66	6 to 4		"	**
	"	8				**		GND	2.4 V	"	66	7 to 4		"	**
	I _{IH2}	9	5.5 V	GND		"				"	"	1 to 4		1	mA
	"	10	GND	5.5 V		"				"	66	2 to 4		"	**
	"	11				**		5.5 V	GND	"	66	6 to 4		"	**
	"	12				**		GND	5.5 V	"	"	7 to 4		"	**
	l _{IL1}	13	0.4 V	GND		"				"	66	1 to 4		-1.6	mA
	"	14	GND	0.4 V		"				"	66	2 to 4		"	66
	"	15				**		0.4 V	GND	"	66	6 to 4		"	**
	"	16				66		GND	0.4 V	"	66	7 to 4		"	**
	I _{CCH3}	17	GND	GND		66		GND	GND	"	66	8		17	"
	ICCL7	18	5.5 V	5.5 V		66		5.5 V	5.5 V	"	66	8		79	**
	V _{OL4}	19	2 V	2 V	100 mA	"				4.5 V	66	3 to 4		0.5	V
	V _{OL4}	20				66	100 mA	2 V	2 V	"	66	5 to 4		0.5	**
	VOL8	21	2 V	2 V	300 mA	"				"	66	3 to 4		0.8	"
	V _{OL8}	22				"	300 mA	2 V	2 V	"	65	5 to 4		0.8	"
	I _{OH4}	23	0.8 V	0.8 V	30 V	"				"	66	3		300	μA
	IOH4	24				**	30 V	0.8 V	0.8 V	"	"	5		300	**

TABLE III. Group A inspection for device type 05.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	Vcc		terminal	Min	Max	
2	VIC	25	-12 mA	4.5 V		GND				4.5 V	See figure	1 to 4		-1.5	V
TA =	"	26	4.5 V	-12 mA		"				ű	5 for test	2 to 4		"	"
+125°C	"	27				**		-12 mA	4.5 V	"	circuit	6 to 4		"	"
	"	28				"		4.5 V	-12 mA	"	"	7 to 4		"	"
	I _{IH1}	29	2.4 V	GND		"				5.5 V	"	1 to 4		40	μΑ
	"	30	GND	2.4 V		66				ű	"	2 to 4		"	"
	"	31				"		2.4 V	GND	"	"	6 to 4		"	"
	"	32				**		GND	2.4 V	"	"	7 to 4		"	"
	I _{IH2}	33	5.5 V	GND		55				"	"	1 to 4		1	mA
	"	34	GND	5.5 V		66				"	"	2 to 4		"	"
	"	35				**		5.5 V	GND	"	"	6 to 4		"	"
	"	36				**		GND	5.5 V	"	"	7 to 4		"	"
	l _{IL1}	37	0.4 V	GND		"				"	"	1 to 4		-1.6	mA
	"	38	GND	0.4 V		"				ű	"	2 to 4		"	"
	"	39				"		0.4 V	GND	"	"	6 to 4		"	"
	"	40				"		GND	0.4 V	"	"	7 to 4		"	"
	I _{CCH3}	41	GND	GND		"		GND	GND	ű	"	8		17	"
	ICCL7	42	5.5 V	5.5 V		"		5.5 V	5.5 V	ű	"	8		79	"
	V _{OL4}	43	2 V	2 V	100 mA	"				4.5 V	"	3 to 4		0.5	V
	V _{OL4}	44				"	100 mA	2 V	2 V	ű	"	5 to 4		0.5	"
	Vol8	45	2 V	2 V	300 mA	55				"	"	3 to 4		0.8	"
	V _{OL8}	46				"	300 mA	2 V	2 V	"	"	5 to 4		0.8	"
	I _{OH4}	47	0.8 V	0.8 V	30 V	"				"	"	3		300	μΑ
	IOH4	48				"	30 V	0.8 V	0.8 V	"	"	5		300	"

TABLE III. Group A inspection for device type 05 - Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	V _{CC}		terminal	Min	Max	
3	VIC	49	-12 mA	4.5 V		GND				4.5 V	See figure	1 to 4		-1.5	V
T _A =	"	50	4.5 V	-12 mA		"				"	5 for test	2 to 4		"	"
-55°C	"	51				"		-12 mA	4.5 V	"	circuit	6 to 4		"	**
	"	52				"		4.5 V	-12 mA	"	66	7 to 4		"	"
	liH1	53	2.4 V	GND		"				5.5 V	66	1 to 4		40	μA
	"	54	GND	2.4 V		"				"	66	2 to 4		"	"
	"	55				"		2.4 V	GND	"	66	6 to 4		"	**
	"	56				"		GND	2.4 V	"	66	7 to 4		"	"
	I _{IH2}	57	5.5 V	GND		"				"	66	1 to 4		1	mA
	"	58	GND	5.5 V		"				"	66	2 to 4		"	"
	"	59				"		5.5 V	GND	"	"	6 to 4		"	"
	"	60				"		GND	5.5 V	"	66	7 to 4		"	**
	l _{IL1}	61	0.4 V	GND		"				"	66	1 to 4		-1.6	mA
	"	62	GND	0.4 V		"				"	66	2 to 4		"	"
	"	63				"		0.4 V	GND	"	66	6 to 4		"	"
	"	64				"		GND	0.4 V	"	66	7 to 4		"	**
	Ісснз	65	GND	GND		"		GND	GND	"	"	8		17	"
	ICCL7	66	5.5 V	5.5 V		"		5.5 V	5.5 V	"	66	8		79	"
	V _{OL4}	67	2 V	2 V	100 mA	"				4.5 V	"	3 to 4		0.5	V
	VOL4	68				"	100 mA	2 V	2 V	"	66	5 to 4		0.5	"
	V _{OL8}	69	2 V	2 V	300 mA	"				"	66	3 to 4		0.8	"
	V _{OL8}	70				"	300 mA	2 V	2 V	"	66	5 to 4		0.8	"
	IOH4	71	0.8 V	0.8 V	30 V	"				"	66	3		300	μΑ
	I _{OH4}	72				"	30 V	0.8 V	0.8 V	"	£5	5		300	"

TABLE III. Group A inspection for device type 05 - Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	Vcc		terminal	Min	Max	
9	t _{PLH}	73	IN	GND	OUT	GND				4.5 V	See figure 9	1 to 3		45	ns
T _A =	"	74	GND	IN	OUT	"				"	for test	2 to 3		"	"
+25°C	"	75				"	OUT	IN	GND	"	circuit and	6 to 5		"	"
	"	76				"	OUT	GND	IN	"	waveforms	7 to 5		"	"
	t PHL	77	IN	GND	OUT	"				4.5 V	"	1 to 3		35	"
	"	78	GND	IN	OUT	"				"	"	2 to 3		"	"
	"	79				"	OUT	IN	GND	"	"	6 to 5		"	"
	"	80				"	OUT	GND	IN	"	"	7 to 5		"	"
	t _{TLH}	81	IN	IN	OUT	"				"	"	3		14	"
	t _{TLH}	82				"	OUT	IN	IN	"	"	5		14	**
	t THL	83	IN	IN	OUT	"				"	"	3		20	"
	t _{THL}	84				"	OUT	IN	IN	"	£6	5		20	"
10	t _{PLH}	85	IN	GND	OUT	GND				4.5 V	"	1 to 3		75	ns
T _A =	"	86	GND	IN	OUT	"				"	"	2 to 3		"	"
+125°C	"	87				"	OUT	IN	GND	"	£6	6 to 5		"	"
	"	88				"	OUT	GND	IN	"	"	7 to 5		"	**
	t PHL	89	IN	GND	OUT	"				4.5 V	"	1 to 3		55	"
	"	90	GND	IN	OUT	"				"	£6	2 to 3		"	"
	"	91				"	OUT	IN	GND	"	"	6 to 5		"	**
	"	92				"	OUT	GND	IN	"	"	7 to 5		"	"
	t _{TLH}	93	IN	IN	OUT	"				"	"	3		18.5	"
	t _{TLH}	94				"	OUT	IN	IN	"	"	5		18.5	**
	t THL	95	IN	IN	OUT	"				"	"	3		25	"
	t _{THL}	96				"	OUT	IN	IN	"	£6	5		25	"

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	V _{CC}		terminal	Min	Max	
11	tPLH	97	IN	GND	OUT	GND				4.5 V	See figure 9	1 to 3		75	ns
T _A =	"	98	GND	IN	OUT	"				"	for test	2 to 3		"	"
-55°C	"	99				"	OUT	IN	GND	"	circuit and	6 to 5		**	"
	"	100				"	OUT	GND	IN	"	waveforms	7 to 5		"	"
	tPHL	101	IN	GND	OUT	"				4.5 V	"	1 to 3		55	"
	"	102	GND	IN	OUT	"				"	"	2 to 3		**	"
	"	103				"	OUT	IN	GND	"	"	6 to 5		**	"
	"	104				"	OUT	GND	IN	"	"	7 to 5		**	**
	t _{TLH}	105	IN	IN	OUT	"				"	"	3		18.5	"
	t _{TLH}	106				"	OUT	IN	IN	"	"	5		18.5	"
	t _{THL}	107	IN	IN	OUT	"				"	"	3		25	"
	t _{THL}	108				"	OUT	IN	IN	"	"	5		25	"

 TABLE III.
 Group A inspection for device type 05.
 Continued.

TABLE III. Group A inspection for device type 06.

Subgroup	Symbol	Test	1	2	17	12	15	16	4	3	5	8	9	10	11	7	6	Relays ener-		leasure termina		Equations	Note	Test	limits	Unit
		no.	V _{S1}	V _{S2}	V _{S3}	1B	1C	1E	2B	2E	2C	V _{CC}	G	1A	1Y	2A	2Y	gized	No.	Value	Unit			Min	Max	ł
1	VIC	1										4.5 V	-12 mA	4.5 V		4.5 V		None	9	E1	V	V _{IC} = E1	See		-1.5	V
T _A =	VIC	2										4.5 V	4.5 V	-12 mA		4.5 V		"	10	E2	V	$V_{IC} = E2$	figure 3		-1.5	V
+25°C	VIC	3										4.5 V	4.5 V	4.5 V		-12 mA		"	7	E3	V	$V_{IC} = E3$	for test		-1.5	V
	I _{IH1}	4										5.5 V	GND	2.4 V		GND		"	10	11	Α	I _{IH1} = I1	circuit		40	μΑ
	I _{IH1}	5										"	"	GND		2.4 V		**	7	12	**	I _{IH1} = I2	"		40	μA
	I _{IH2}	6										"	"	5.5 V		GND		**	10	13	"	$I_{IH2} = I3$	"		1	mA
	I _{IH2}	7										"	"	GND		5.5 V		**	7	14	"	$I_{IH2} = I4$	"		1	mA
	I _{IH3}	8										"	2.4 V	GND		GND		**	9	15	"	I _{IH3} = 15	"		80	μΑ
	I _{IH4}	9										**	5.5 V	GND		GND		**	9	16	"	I _{IH4} = 16	"		2	mA
	I _{IL1}	10										"	5.5 V	0.4 V		5.5 V		"	10	17	"	I _{IL1} = 17	"		-1.6	mA
	l _{IL1}	11										"	5.5 V	5.5 V		0.4 V		**	7	18	"	I _{IL1} = 18	"		-1.6	"
	I _{IL2}	12										"	0.4 V	5.5 V		5.5 V		**	9	19	"	$I_{1L2} = 19$	"		-3.2	"
	ICCH1	13										"	GND	GND		GND		**	8	l10	"	I _{ССН1} = I10	**		4	"
	ICCL1	14										"	5.5 V	5.5 V		5.5 V		"	8	l11	"	I _{CCL1} =	"		11	"
	Vol9	15										4.5 V	2 V	2 V	I _{OL} = 16 mA			"	11	E4	V	V _{OL9} = E4	"		0.5	V
	Vol9	16										"	2 V			2 V	I _{OL} = 16 mA	"	6	E5	"	V _{OL9} = E5	"		0.5	"
	Vон	17										"	4.5 V	0.8 V	Іон = - 400 μА			"	11	E6	"	Vон = E6	"	2.4		"
	Vон	18										"	4.5 V			0.8 V	I _{OH} = - 400 μA	"	6	E7	"	V _{OH} = E7	"	2.4		"
	los1	19										5.5 V	GND	GND	GND			"	11	l12	Α	los1 = 112	"		-55	mA
	los1	20										5.5 V	"			GND	GND	**	6	113	**	IOS1 = 113	"		-55	mA
	I _{OS2}	21										4.5 V	"	GND	GND			**	11	l14	"	I _{OS2} = 114	"	-18		"
	I _{OS2}	22										4.5 V	"			GND	GND	**	6	I15	"	I _{OS2} = 115		-18		"
	h _{FE1}	23	4 V	V S 2														"	18 to 14	E8	v	hFE1 = E8/1000	See figures 3 and 4	25		
	h _{FE1}	24	4 V	"														3	"	E9	"	h _{FE1} = E9/1000	for test	25		
	h _{FE2}	25	6 V	"														None	ű	E10	"	h _{FE2} = E10/3000	circuit	30		
	h _{FE2}	26	6 V	u														3	"	E11	"	h _{FE2} = E11/3000	and waveforms	30		
	V _{BE1}	27	4 V	"	V S 3													1,2	12 to 16	E12	"	V _{BE1} = E12	"		1.2	V
	V_{BE1}	28	4 V	"	V S 3													1,2,3	4 to 3	E13	"	V _{BE1} = E13	"		1.2	v

Test Relays Measured Subgroup Symbol 1 2 17 12 15 16 4 3 5 8 9 10 11 7 6 Equations Note Test limits Unit terminal no. ener- V_{S2} 1B 1C 1E 2B 2E 2C G 1A 1Y 2A 2Y No. Value Unit Min Max V_{S1} V_{S3} Vcc gized 12 1 V_{BE2} See figures $V_{BE2} =$ VS2 V V 29 6 V VS3 1,2 to E14 1.4 3 and 4 T_A = E14 16 +25°C VBE2 4 to VBE2 = " " 6 V " E15 30 1,2,3 for test 1.4 V 3 E15 15 VCESAT1 " VCESAT1 " E16 " " 31 4 V 1,2 circuit 0.5 to = E16 16 and 5 to VCESAT1 VCESAT1 " " 32 4 V " 1,2,3 E17 0.5 " 3 waveforms = E17 15 VCESAT2 VCESAT2 " 33 6 V " E18 " " " 1,2 to 0.8 = E18 16 5 to VCESAT2 VCESAT2 " " 34 6 V " E19 " " 1,2,3 0.8 3 = E19 15 VCB02 100 V_{CB02} = " " " 35 GND 3 E20 40 to μΑ E20 12 100 5 to V_{CB02} V_{CB02} = GND E21 " " " 36 4 40 μA 4 E21 15 " VCER2 100 VCER2 = " " 37 GND E22 4 to 40 μΑ E22 16 100 5 to VCER2 VCER2 = " " 38 GND 3,4 E23 " 40 3 μΑ E23 15 VCEO1 VCEO1 = 39 10 mA GND 3 E24 " " " 25 to E24 16 10 5 to VCEO1 VCEO1 = GND E25 " " " 40 3,4 25 mΑ 3 E25 16 VEBO 100 VEBO = " " 41 GND 3,4 to E26 " 5 μA E26 12 100 3 to V_{EBO} = VEBO " E27 " 5 " 42 GND 4 μA 4 E27 2 43 4.5 V -12 mA 4.5 V 4.5 V None 9 E1 V -1.5 V See Vic $V_{IC} = E1$ 4.5 V 4.5 V -12 mA 4.5 V 10 E2 V figure 3 V 44 $V_{IC} = E2$ -1.5 T_A = Vic " +125°C 45 4.5 V 4.5 V 4.5 V -12 mA 7 E3 V $V_{IC} = E3$ for test -1.5 V Vic 5.5 V 46 GND 2.4 V GND " 10 11 А IIH1 = I1 circuit 40 μA liH1 " " " " 47 GND 2.4 V 7 12 IIH1 = I2 40 liH1 μΑ " " GND " 13 " 48 5.5 V 10 $I_{1H2} = 13$ 1 mΑ I_{IH2} " " " 14 " " 49 GND 5.5 V 7 I_{IH2} = I4 1 mΑ I_{IH2} " " 2.4 V GND GND 9 15 " 50 " I_{IH3} = 15 80 μΑ I_{IH3} " " " 51 5.5 V GND GND 9 16 " $I_{1H4} = 16$ 2 mΑ I_{IH4} 52 4.5 V 4.5 V 17 " -1.6 l_{IL1} " 0.4 V " 10 " $I_{IL1} = 17$ mΑ " " " 53 4.5 V 4.5 V 0.4 V 7 18 " " I_{IL1} = 18 -1.6 l_{IL1} " " " " 54 0.4 V 4.5 V 4.5 V 9 19 " -3.2 IIL2 $I_{1L2} = 19$

TABLE III. Group A inspection for device type 06 - Continued.

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Subgroup	Symbol	Test.	1	2	17	12	15	16	4	3	5	8	9	10	11	7	6	Relays ener-		leasure terminal		Equations	Note	Test I	imits	Unit
		no	V _{S1}	V _{S2}	V _{S3}	1B	1C	1E	2B	2E	2C	V _{CC}	G	1A	1Y	2A	2Y	gized	No.	Value	Unit			Min	Max	
2	I _{CCH1}	55										5.5 V	GND	GND		GND		None	8	l10	ű	I _{CCH1} =	See		4	mA
T _A =	ICCL1	56										**	5.5 V	5.5 V		5.5 V		"	8	l11	u	I _{CCL1} =	figure 3		11	**
+125°C	Vol9	57										4.5 V	2 V	2 V	I _{OL} = 16 mA			"	11	E4	۷	V _{OL9} = E4	for test		0.5	V
	V _{OL9}	58										"	2 V			2 V	I _{OL} = 16 mA	"	6	E5	"	V _{OL9} = E5	circuit		0.5	"
	V _{OH}	59										"	4.5 V	0.8 V	I _{OH} = - 400 μA			"	11	E6	u	V _{OH} = E6	"	2.4		"
	V _{OH}	60										"	4.5 V		400 μ/	0.8 V	I _{OH} = -	"	6	E7	u	V _{OH} = E7	"	2.4		"
	I _{OS1}	61										5.5 V	GND	GND	GND		400 μA	"	11	l12	А	I _{OS1} = I12	"		-55	mA
	los1	62										5.5 V	"			GND	GND	"	6	I13	"	$I_{OS1} = I13$	"		-55	"
	I _{OS2}	63										4.5 V	"	GND	GND			"	11	I14	"	I _{OS2} = 114	"	-18		"
	los2	64										4.5 V	"			GND	GND	"	6	l15	"	I _{OS2} = 115	"	-18		u
	h _{FE1}	65	4 V	V S 2														"	18 to 14	E8	V	hFE1 = E8/1000	See figures 3 and 4	25		
	h _{FE1}	66	4 V	"														3	"	E9	"	h _{FE1} = E9/1000	for test	25		
	h _{FE2}	67	6 V	"														None	"	E10	"	h _{FE2} = E10/3000	circuit	30		
	h _{FE2}	68	6 V	"														3	"	E11	u	h _{FE2} = E11/3000	and waveforms	30		
	V _{BE1}	69	4 V	"	V s 3													1,2	12 to 16	E12	"	V _{BE1} = E12	"		1.2	V
	V_{BE1}	70	4 V	"	V S 3													1,2,3	4 to 3	E13	"	V _{BE1} = E13	"		1.2	V
	V_{BE2}	71	6 V	"	V S 3													1,2	12 to 16	E14	V	V _{BE2} = E14	"		1.4	v
	V_{BE2}	72	6 V	"	"													1,2,3	4 to 3	E15	u	V _{BE2} = E15	"		1.4	V
	VCESAT 1	73	4 V	"	"													1,2	15 to 16	E16	"	VCESAT1 = E16	"		0.5	"
	VCESAT 1	74	4 V	"	"													1,2,3	5 to 3	E17	"	V _{CESAT1} = E17	"		0.5	"
	VCESAT 2	75	6 V	"	"													1,2	15 to 16	E18	"	V _{CESAT2} = E18	"		0.8	"
	VCESAT 2	76	6 V	"	"													1,2,3	5 to 3	E19	"	V _{CESAT2} = E19	"		0.8	"

TABLE III. Group A inspection for device type 06 – Continued.

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Subgroup	Symbol	Test.	1	2	17	12	15	16	4	3	5	8	9	10	11	7	6	Relays ener-	Measu	ured ter	minal	Equations	Note	Test	limits	Unit
		no	V _{S1}	V _{S2}	V _{S3}	1B	1C	1E	2B	2E	2C	V _{CC}	G	1A	1Y	2A	2Y	gized	No.	Value	Unit			Min	Max	1
2	V _{CB02}	77				GND	100 μA											3	15 to 12	E20	"	V _{CB02} = E20	See figure	40		V
T _A =	V _{CB02}	78							GND		100 μΑ							4	5 to 4	E21	"	V _{CB02} = E21	3 for test	40		"
+125°C	V _{CER2}	79					100 μA	GND										4	15 to 16	E22	"	V _{CER2} = E22	circuit	40		"
	V _{CER2}	80								GND	100 μΑ							3,4	5 to 3	E23	"	V _{CER2} = E23	"	40		"
	V _{CEO1}	81					10 mA	GND										3	15 to 16	E24	"	V _{CEO1} = E24	"	25		"
	V _{CEO1}	82								GND	10 mA							3,4	5 to 3	E25	"	V _{CEO1} = E25	"	25		"
	V _{EBO}	83				GND		100 μΑ										3,4	16 to 12	E26	"	V _{EBO} = E26	"	5		"
	V _{EBO}	84							GND		100 μΑ							4	3 to 4	E27	"	V _{EBO} = E27	"	5		"
3	VIC	85										4.5 V	-12 mA	4.5 V		4.5 V		None	9	E1	V	$V_{IC} = E1$	See figure		-1.5	V
T _A =	VIC	86										4.5 V	4.5 V	-12 mA		4.5 V		"	10	E2	V	$V_{IC} = E2$	3 for test		-1.5	V
-55°C	VIC	87										4.5 V	4.5 V	4.5 V		-12 mA		**	7	E3	V	V _{IC} = E3	circuit		-1.5	v
	I _{IH1}	88										5.5 V	GND	2.4 V		GND		"	10	11	Α	I _{IH1} = I1	"		40	μA
	l _{IH1}	89										"	**	GND		2.4 V		**	7	12	"	l _{IH1} = l2	"		40	μA
	lih2	90										"	"	5.5 V		GND		"	10	13	"	I _{IH2} = I3	"		1	mA
	liH2	91										"	**	GND		5.5 V		**	7	14	"	$I_{1H2} = 14$	"		1	mA
	Іінз	92										"	2.4 V	GND		GND		"	9	15	"	I _{IH3} = I5	"		80	μA
	I _{IH4}	93										"	5.5 V	GND		GND		**	9	16	"	I _{IH4} = 16	"		2	mA
	l _{IL1}	94										"	4.5 V	0.4 V		4.5 V		**	10	17	"	I _{IL1} = 17	"		-1.6	mA
	l _{IL1}	95										"	4.5 V	4.5 V		0.4 V		**	7	18	"	I _{IL1} = 18	"		-1.6	"
	I _{IL2}	96										"	0.4 V	4.5 V		4.5 V		"	9	19	"	I _{IL2} = 19	u		-3.2	"
	ICCH1	97										"	GND	GND		GND		"	8	110	"	I _{CCH1} = 110	"		4	ns
	ICCL1	98										"	5.5 V	5.5 V		5.5 V		"	8	111	"	ICCL1 = 111	"		11	"
	V _{OL9}	99										4.5 V	2 V	2 V	I _{OL} = 16 mA			"	11	E4	V	V _{OL9} = E4	"		0.5	V
	Vol9	100										"	2 V			2 V	I _{OL} = 16 mA	"	6	E5	"	V _{OL9} = E5	u		0.5	"
	V _{OH}	101										"	4.5 V	0.8 V	I _{OH} = - 400 μA			"	11	E6	"	V _{OH} = E6	"	2.4		"
	Voh	102										"	4.5 V			0.8 V	IOH = - 400 μA	"	6	E7	"	V _{OH} = E7	"	2.4		"

TABLE III. Group A inspection for device type 06 – Continued.

Subgroup	Symbol	Test.	1	2	17	12	15	16	4	3	5	8	9	10	11	7	6	Relays ener-	Measu	red tern	ninal	Equations	Note	Test	limits	Unit
		no	V _{S1}	V _{S2}	V _{S3}	1B	1C	1E	2B	2E	2C	V _{CC}	G	1A	1Y	2A	2Y	gized	No.	Value	Unit			Min	Max	
3	IOS1	103										5.5 V	GND	GND	GND			None	11	l12	Α	IOS1 = I12	See figure		-55	mA
TA =	IOS1	104										5.5 V	**			GND	GND	"	6	l13	"	IOS1 = I13	3 for test		-55	"
-55°C	I _{OS2}	105										4.5 V	"	GND	GND	0.15	0.115	"	11	114	"	$I_{OS2} = 114$	circuit	-18		"
	I _{OS2}	106									-	4.5 V				GND	GND		6	l15		$I_{OS2} = 115$	" Coo figuroo	-18		
	hFE3	107	4 V	V S 2														"	18 to 14	E8	V	h _{FE3} = E8/1000	See figures 3 and 4	10		
	h _{FE3}	108	4 V	"														3	"	E9	"	h _{FE3} = E9/1000	for test	10		
	h _{FE4}	109	6 V	"														None	"	E10	"	h _{FE4} = E10/3000	circuit	15		
	h _{FE4}	110	6 V	"														3	"	E11	u	h _{FE4} = E11/3000	and waveforms	15		
	V_{BE1}	111	4 V	"	V S 3													1,2	12 to 16	E12	u	V _{BE1} = E12	"		1.2	V
	V_{BE1}	112	4 V	"	V S 3													1,2,3	4 to 3	E13	"	V _{BE1} = E13	"		1.2	v
	V _{BE2}	113	6 V	u	V S 3													1,2	12 to 16	E14	V	V _{BE2} =	"		1.4	V
	V _{BE2}	114	6 V	"	"													1,2,3	4 to 3	E15	u	E14 V _{BE2} =	"		1.4	v
	V _{CESAT1}	115	4 V	"	"													1,2	15 to	E16	u	E15 V _{CESAT1}	"		0.5	"
	VCESAT1	116	4 V	"	"													1,2,3	16 5 to 3	E17	ű	= E16 V _{CESAT1}	**		0.5	"
	VCESAT2	117	6 V	"	"													1,2	15 to	E18	u	= E17 V _{CESAT2}	"		0.8	"
	VCESAT2	117	6 V	"	"														16	E19	"	= E18 V _{CESAT2}	"		0.8	"
			0 0	"	"	OND	100											1,2,3	5 to 3 15 to		"	= E19 V _{CB02} =	***	40	0.0	"
	VCB02	119		"	"	GND	μA				100							3	12	E20		E20 V _{CB02} =	"	40		"
	VCB02	120					100		GND		μA							4	5 to 4 15 to	E21		E21		40		
	VCER2	121		"	"		μA	GND			100							4	16	E22	"	V _{CER1} = E22	"	40		"
	VCER2	122		"	"					GND	100 μΑ							3,4	5 to 3	E23	"	V _{CER1} = E23	**	40		"
	VCEO1	123					10 mA	GND										3	15 to 16	E24	u	V _{CEO1} = E24	"	25		"
	VCEO1	124								GND	10 mA							3,4	5 to 3	E25	"	V _{CEO1} = E25	"	25		"
	VEBO	125				GND		100 μΑ										3,4	16 to 12	E26	u	V _{EBO} = E26	"	5		"
	VEBO	126							GND		100 μΑ							4	3 to 4	E27	u	V _{EBO} = E27	"	5		"

TABLE III. Group A inspection for device type 06 – Continued.

Subgroup	Symbol	Test no.	1	2	3	4	5	6	7	8	9	10	11	12	13	14	Notes	Measured	Test	limits	Unit
			G	1A	1Y	1B	1C	1E	GND	Sub	2E	2C	2B	2Y	2A	V _{CC}		terminal	Min	Max	
9	tD	127				Α	В	GND		GND							See figure 8	5		15	ns
T _A =	tD	128								"	GND	В	А				for test	10		15	"
+25°C	ts	129				А	В	GND		"							circuit and	5		23	"
	ts	130								**	GND	В	Α				waveforms	10		23	"
	t _R	131				A	В	GND		"							"	5		20	"
	t _R	132								"	GND	В	А				"	10		20	"
	tF	133				A	В	GND		"		_					"	5		15	"
	t _F	134								"	GND	В	A					10		15	"
	tPLH1	135 136	3 V IN	IN 3 V	OUT OUT					"						4.5 V "	See figure 6 for test	2 to 3 1 to 3		30 "	"
	"	130	3 V	3 V	001					"				OUT	IN	"	circuit and	13 to 12		"	"
	"	138	IN							"				OUT	3 V	"	waveforms	1 to 12		"	"
	tPHL1	139	3 V	IN	OUT					"						4.5 V	"	2 to 3		15 "	"
	"	140 141	IN 3 V	3 V	OUT					"				OUT	IN	"	"	1 to 3 13 to 12		"	"
	"	142	IN							**				OUT	3 V	"	"	1 to 12		"	"
	t _{PLH3}	143	3 V	IN	Connect to 1B		OUT			"						4.5 V	See figure 7	2 to 5		65	"
	"	144	IN	3 V	Connect to 1B		OUT			"						"	for test	1 to 5		"	"
	"	145	3 V							**		OUT		Connect to 2B	IN	"	circuit and	13 to 10		"	"
	"	146	IN							"		OUT		Connect to 2B	3 V	"	waveforms	1 to 10		"	"
	t _{PHL3}	147	3 V	IN	Connect to 1B		OUT			"						4.5 V	"	2 to 5		50	"
	"	148	IN	3 V	Connect to 1B		OUT			**						"	"	1 to 5		"	"
	"	149	3 V							**		OUT		Connect to 2B	IN	"	"	13 to 10		"	"
	"	150	IN							"		OUT		Connect to 2B	3 V	"	"	1 to 10		"	"
	t _{TLH2}	151	3 V	IN	Connect to 1B		OUT			"						"	u	5		20	"
	t _{TLH2}	152	3 V							**		OUT		Connect to 2B	IN	"	"	10		"	"
	tTHL2	153	3 V	IN	Connect to 1B		OUT			"						"	"	5		"	"
	t _{THL2}	154	3 V							"		OUT		Connect to 2B	IN	"	"	10		"	u

TABLE III. Group A inspection for device type 06 – Continued.

Subgroup	Symbol	Test no.	1	2	3	4	5	6	7	8	9	10	11	12	13	14	Notes	Measured	Test	limits	Unit
			G	1A	1Y	1B	1C	1E	GND	Sub	2E	2C	2B	2Y	2A	V _{CC}		terminal	Min	Max	
10	tD	155				Α	В	GND		GND							See figure 8	5		22.5	ns
$T_A =$	tD	156								"	GND	В	А				for test	10		22.5	"
+125°C	ts	157				Α	В	GND		"							circuit and	5		34.5	"
	ts	158								**	GND	В	Α				waveforms	10		34.5	"
	t _R	159				Α	В	GND		"							"	5		30	"
	t _R	160								"	GND	В	Α				**	10		30	"
	tF	161				Α	В	GND		"							**	5		22.5	"
	tF	162								"	GND	В	Α				"	10		22.5	"
	tPLH1	163	3 V	IN	OUT					"						4.5 V	See figure 6	2 to 3		45	"
	"	164 165	IN 3 V	3 V	OUT					"				OUT	IN	"	for test circuit and	1 to 3 13 to 12		"	"
	"	166	IN							**				OUT	3 V	"	waveforms	1 to 12		"	"
	tPHL1	167	3 V	IN	OUT					"						4.5 V	"	2 to 3		22.5	"
	"	168	IN	3 V	OUT					"						"	"	1 to 3		"	"
	"	169 170	3 V IN							"				OUT OUT	IN 3 V	"	"	13 to 12 1 to 12		"	"
	t _{PLH3}	171	3 V	IN	Connect		OUT			"				001	01	4.5 V	See figure 7	2 to 5		90	"
	"	17.1	3 V		to 1B		001									4.5 V	See ligule /	2 10 5		90	"
		172	IN	3 V	Connect to 1B		OUT			**						"	for test	1 to 5		"	
	u	173	3 V							"		OUT		Connect to 2B	IN	**	circuit and	13 to 10		"	"
	u	174	IN							"		OUT		Connect to 2B	3 V	**	waveforms	1 to 10		"	"
	tPHL3	175	3 V	IN	Connect to 1B		OUT			"						4.5 V	"	2 to 5		75	"
	"	176	IN	3 V	Connect to 1B		OUT			"						**	"	1 to 5		u	"
	"	177	3 V							"		OUT		Connect to 2B	IN	**	"	13 to 10		"	"
	"	178	IN							"		OUT		Connect to 2B	3 V	**	"	1 to 10		"	"
	tTLH2	179	3 V	IN	Connect to 1B		OUT			"						"	"	5		30	"
	ttlH2	180	3 V							"		OUT		Connect to 2B	IN	"	"	10		"	"
	tTHL2	181	3 V	IN	Connect to 1B		OUT			"						"	"	5		"	"
	tTHL2	182	3 V							"		OUT		Connect to 2B	IN	"	"	10		u	"

 TABLE III.
 Group A inspection for device type 06
 – Continued.

Subgroup	Symbol	Test no.	1	2	3	4	5	6	7	8	9	10	11	12	13	14	Notes	Measured	Test	limits	Unit
			G	1A	1Y	1B	1C	1E	GND	Sub	2E	2C	2B	2Y	2A	V _{CC}		terminal	Min	Max	
11	tD	183				Α	В	GND		GND							See figure 8	5		22.5	ns
T _A =	tD	184								"	GND	В	А				for test	10		22.5	**
-55°C	ts	185				Α	В	GND		"							circuit and	5		34.5	"
	ts	186								"	GND	В	А				waveforms	10		34.5	**
	t _R	187				Α	В	GND		"							"	5		30	"
	t _R	188								"	GND	В	А				**	10		30	**
	tF	189				А	В	GND		"							**	5		22.5	**
	t _F	190								"	GND	В	A				"	10		22.5	"
	tPLH1	191	3 V	IN	OUT					"						4.5 V	See figure 6	2 to 3		45 "	"
	"	192 193	IN 3 V	3 V	OUT					"				OUT	IN	"	for test circuit and	1 to 3 13 to 12		"	"
	"	194	IN							"				OUT	3 V	"	waveforms	1 to 12		"	"
	tPHL1	195	3 V	IN	OUT					"						4.5 V	**	2 to 3		22.5	"
	"	196	IN	3 V	OUT					"						"	**	1 to 3		"	"
	"	197 198	3 V IN							"			OUT	OUT 3 V	IN	"	"	13 to 12 1 to 12		"	"
	t _{PLH3}	199	3 V	IN	Connect		OUT			"			001	0 1		4.5 V	See figure 7	2 to 5		90	"
	"	199	3 V	IIN	to 1B		001									4.5 V	See ligule /	2 10 5		90	"
		200	IN	3 V	Connect to 1B		OUT			"						"	for test	1 to 5		"	
	"	201	3 V		10 12					"		OUT		Connect to 2B	IN	"	circuit and	13 to 10		"	"
	"	202	IN							"		OUT		Connect to 2B	3 V	"	waveforms	1 to 10		"	"
	tPHL3	203	3 V	IN	Connect to 1B		OUT			"						4.5 V	"	2 to 5		75	"
	"	204	IN	3 V	Connect to 1B		OUT			"						"	"	1 to 5		"	"
	"	205	3 V							"		OUT		Connect to 2B	IN	"	"	13 to 10		"	"
	"	206	IN							"		OUT		Connect to 2B	3 V	"	"	1 to 10		"	"
	ttlH2	207	3 V	IN	Connect to 1B		OUT			"						"	"	5		30	"
	ttlH2	208	3 V							"		OUT		Connect to 2B	IN	"	"	10		"	"
	tTHL2	209	3 V	IN	Connect to 1B		OUT			"						"	"	5		"	"
	t _{THL2}	210	3 V							"		OUT		Connect to 2B	IN	"	"	10		u	"

TABLE III. Group A inspection for device type 06 – Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	Vcc		terminal	Min	Max	
1	VIC	1	-12 mA	4.5 V		GND				4.5 V	See figure	1 to 4		-1.5	V
T _A =	"	2	4.5 V	-12 mA		"				"	5 for test	2 to 4		"	"
+25°C	"	3				"		-12 mA	4.5 V	"	circuit	6 to 4		"	"
	"	4				**		4.5 V	-12 mA	"	66	7 to 4		"	"
	liH1	5	2.4 V	GND		**				5.5 V	**	1 to 4		40	μA
	"	6	GND	2.4 V		**				"	**	2 to 4		"	
	"	7				**		2.4 V	GND	"	**	6 to 4		"	
	"	8				**		GND	2.4 V	"	66	7 to 4		"	
	I _{IH2}	9	5.5 V	GND		**				"	"	1 to 4		1	mA
	"	10	GND	5.5 V		**				"	66	2 to 4		"	"
	"	11				**		5.5 V	GND	"	66	6 to 4		"	"
	"	12				"		GND	5.5 V	"	**	7 to 4		"	"
	I _{IL1}	13	0.4 V	5.5 V		**				"	"	1 to 4		-1.6	mA
	"	14	5.5 V	0.4 V		**				"	66	2 to 4		"	"
	"	15				"		0.4 V	5.5 V	"	"	6 to 4		"	"
	"	16				**		5.5 V	0.4 V	"	66	7 to 4		"	"
	ICCH2	17	5.5 V	5.5 V		**		5.5 V	5.5 V	"	"	8		11	"
	I _{CCL5}	18	GND	GND		**		GND	GND	"	66	8		76	"
	V _{OL1}	19	0.8 V	0.8 V	100 mA	"				4.5 V	66	3 to 4		0.5	V
	VOL1	20				"	100 mA	0.8 V	0.8 V	"	"	5 to 4		0.5	"
	V _{OL5}	21	0.8 V	0.8 V	300 mA	**				"	"	3 to 4		0.8	"
	V _{OL5}	22				**	300 mA	0.8 V	0.8 V	"	**	5 to 4		0.8	"
	IOH1	23	2 V	2 V	30 V	"				"	**	3		300	μA
	I _{OH1}	24				"	30 V	2 V	2 V	"	"	5		300	"

TABLE III. Group A inspection for device type 07.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	V _{CC}		terminal	Min	Max	
2	VIC	25	-12 mA	4.5 V		GND				4.5 V	See figure	1 to 4		-1.5	V
T _A =	"	26	4.5 V	-12 mA		"				"	5 for test	2 to 4		"	"
+125°C	"	27				"		-12 mA	4.5 V	"	circuit	6 to 4		"	"
	"	28				"		4.5 V	-12 mA	"	"	7 to 4		"	"
	liH1	29	2.4 V	GND		"				5.5 V	"	1 to 4		40	μA
	"	30	GND	2.4 V		"				"	"	2 to 4		"	"
	"	31				"		2.4 V	GND	"	"	6 to 4		"	"
	"	32				"		GND	2.4 V	"	"	7 to 4		"	"
	I _{IH2}	33	5.5 V	GND		"				"	ű	1 to 4		1	mA
	"	34	GND	5.5 V		"				"	"	2 to 4		"	"
	"	35				"		5.5 V	GND	"	"	6 to 4		"	"
	"	36				"		GND	5.5 V	"	"	7 to 4		"	"
	l _{IL1}	37	0.4 V	5.5 V		"				"	"	1 to 4		-1.6	mA
	"	38	5.5 V	0.4 V		"				"	"	2 to 4		"	"
	"	39				"		0.4 V	5.5 V	"	"	6 to 4		"	"
	"	40				"		5.5 V	0.4 V	"	"	7 to 4		"	"
	ICCH2	41	5.5 V	5.5 V		"		5.5 V	5.5 V	"	"	8		11	"
	I _{CCL5}	42	GND	GND		"		GND	GND	"	"	8		76	"
	V _{OL1}	43	0.8 V	0.8 V	100 mA	"				4.5 V	"	3 to 4		0.5	V
	VOL1	44				"	100 mA	0.8 V	0.8 V	"	"	5 to 4		0.5	"
	V _{OL5}	45	0.8 V	0.8 V	300 mA	"				"	"	3 to 4		0.8	"
	V _{OL5}	46				"	300 mA	0.8 V	0.8 V	"	"	5 to 4		0.8	"
	IOH1	47	2 V	2 V	30 V	"				"	"	3		300	μΑ
	I _{OH1}	48				"	30 V	2 V	2 V	"	"	5		300	"

 TABLE III.
 Group A inspection for device type 07 – Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	V _{CC}		terminal	Min	Max	
3	VIC	49	-12 mA	4.5 V		GND				4.5 V	See figure	1 to 4		-1.5	V
T _A =	"	50	4.5 V	-12 mA		"				"	5 for test	2 to 4		**	"
-55°C	"	51				"		-12 mA	4.5 V	"	circuit	6 to 4		"	"
	"	52				"		4.5 V	-12 mA	"	"	7 to 4		**	"
	liH1	53	2.4 V	GND		"				5.5 V	"	1 to 4		40	μA
	"	54	GND	2.4 V		"				"	"	2 to 4		**	"
	"	55				"		2.4 V	GND	"	"	6 to 4		**	"
	"	56				"		GND	2.4 V	"	"	7 to 4		**	"
	I _{IH2}	57	5.5 V	GND		"				"	"	1 to 4		1	mA
	"	58	GND	5.5 V		"				"	"	2 to 4		**	"
	"	59				"		5.5 V	GND	"	"	6 to 4		**	"
	"	60				"		GND	5.5 V	"	"	7 to 4		**	"
	l _{IL1}	61	0.4 V	5.5 V		"				"	"	1 to 4		-1.6	mA
	"	62	5.5 V	0.4 V		"				"	"	2 to 4		**	"
	"	63				"		0.4 V	5.5 V	"	"	6 to 4		**	"
	"	64				"		5.5 V	0.4 V	"	"	7 to 4		**	"
	ICCH2	65	5.5 V	5.5 V		"		5.5 V	5.5 V	"	"	8		11	"
	I _{CCL5}	66	GND	GND		"		GND	GND	"	"	8		76	"
	V _{OL1}	67	0.8 V	0.8 V	100 mA	"				4.5 V	"	3 to 4		0.5	V
	VOL1	68				"	100 mA	0.8 V	0.8 V	"	"	5 to 4		0.5	"
	V _{OL5}	69	0.8 V	0.8 V	300 mA	"				"	"	3 to 4		0.8	"
	V _{OL5}	70				"	300 mA	0.8 V	0.8 V	"	"	5 to 4		0.8	"
	IOH1	71	2 V	2 V	30 V	"				"	"	3		300	μΑ
	I _{OH1}	72				"	30 V	2 V	2 V	"	ű	5		300	"

 TABLE III.
 Group A inspection for device type 07 – Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	V _{CC}		terminal	Min	Max	
9	tPLH	73	IN	3 V	OUT	GND				4.5 V	See figure 9	1 to 3		55	ns
T _A =	"	74	3 V	IN	OUT	"				"	for test	2 to 3		"	"
+25°C	"	75				"	OUT	IN	3 V	"	circuit and	6 to 5		"	"
	"	76				"	OUT	3 V	IN	"	waveforms	7 to 5		"	"
	t PHL	77	IN	3 V	OUT	"				4.5 V	"	1 to 3		40	"
	"	78	3 V	IN	OUT	"				"	"	2 to 3		"	"
	"	79				"	OUT	IN	3 V	"	"	6 to 5		"	"
	"	80				"	OUT	3 V	IN	"	"	7 to 5		"	"
	t _{TLH}	81	IN	IN	OUT	"				"	"	3		20	"
	t _{TLH}	82				"	OUT	IN	IN	"	"	5		"	"
	t⊤HL	83	IN	IN	OUT	"				"	"	3		"	"
	t _{THL}	84				"	OUT	IN	IN	"	"	5		"	"
10	t _{PLH}	85	IN	3 V	OUT	GND				4.5 V	"	1 to 3		65	ns
T _A =	"	86	3 V	IN	OUT	"				"	"	2 to 3		"	"
+125°C	"	87				"	OUT	IN	3 V	"	"	6 to 5		"	"
	"	88				"	OUT	3 V	IN	"	"	7 to 5		"	"
	t PHL	89	IN	3 V	OUT	"				4.5 V	"	1 to 3		60	"
	"	90	3 V	IN	OUT	"				"	"	2 to 3		"	"
	"	91				"	OUT	IN	3 V	"	"	6 to 5		"	"
	"	92				"	OUT	3 V	IN	"	"	7 to 5		"	"
	t _{TLH}	93	IN	IN	OUT	"				"	"	3		26.5	"
	t _{TLH}	94				"	OUT	IN	IN	"	**	5		26.5	"
	t⊤HL	95	IN	IN	OUT	"				"	"	3		25	"
	t _{THL}	96				"	OUT	IN	IN	"	**	5		25	"

TABLE III. Group A inspection for device type 07 – Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	V _{CC}		terminal	Min	Max	
11	tPLH	97	IN	3 V	OUT	GND				4.5 V	See figure 9	1 to 3		65	ns
T _A =	"	98	3 V	IN	OUT	"				"	for test	2 to 3		"	"
-55°C	"	99				"	OUT	IN	3 V	"	circuit and	6 to 5		"	"
	"	100				"	OUT	3 V	IN	"	waveforms	7 to 5		"	"
	tPHL	101	IN	3 V	OUT	"				4.5 V	"	1 to 3		60	"
	"	102	3 V	IN	OUT	"				"	55	2 to 3		"	"
	"	103				"	OUT	IN	3 V	"	"	6 to 5		"	"
	"	104				"	OUT	3 V	IN	"	"	7 to 5		"	"
	t _{TLH}	105	IN	IN	OUT	"				"	55	3		26.5	"
	t _{TLH}	106				"	OUT	IN	IN	"	"	5		26.5	"
	t THL	107	IN	IN	OUT	"				"	"	3		25	"
	t _{THL}	108				"	OUT	IN	IN	"	"	5		25	"

 TABLE III.
 Group A inspection for device type 07
 - Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	Vcc		terminal	Min	Max	
1	VIC	1	-12 mA	4.5 V		GND				4.5 V	See figure	1 to 4		-1.5	V
T _A =	"	2	4.5 V	-12 mA		"				"	5 for test	2 to 4		"	"
+25°C	"	3				"		-12 mA	4.5 V	"	circuit	6 to 4		"	"
	"	4				**		4.5 V	-12 mA	"	**	7 to 4		"	"
	liH1	5	2.4 V	GND		**				5.5 V	"	1 to 4		40	μA
	"	6	GND	2.4 V		**				"	**	2 to 4		"	"
	"	7				**		2.4 V	GND	"	**	6 to 4		"	"
	"	8				**		GND	2.4 V	"	**	7 to 4		"	"
	I _{IH2}	9	5.5 V	GND		**				"	"	1 to 4		1	mA
	"	10	GND	5.5 V		**				"	**	2 to 4		"	"
	"	11				"		5.5 V	GND	"	**	6 to 4		"	"
	"	12				"		GND	5.5 V	"	**	7 to 4		"	"
	I _{IL1}	13	0.4 V	5.5 V		**				"	**	1 to 4		-1.6	mA
	"	14	5.5 V	0.4 V		**				"	**	2 to 4		"	"
	"	15				"		0.4 V	5.5 V	"	**	6 to 4		"	"
	"	16				**		5.5 V	0.4 V	"	**	7 to 4		"	"
	Ісснз	17	GND	GND		**		GND	GND	"	"	8		17	"
	ICCL6	18	5.5 V	5.5 V		**		5.5 V	5.5 V	"	**	8		76	"
	V _{OL2}	19	2 V	2 V	100 mA	"				4.5 V	"	3 to 4		0.5	V
	VOL2	20				"	100 mA	2 V	2 V	"	**	5 to 4		0.5	"
	V _{OL6}	21	2 V	2 V	300 mA	**				"	"	3 to 4		0.8	"
	V _{OL6}	22				**	300 mA	2 V	2 V	"	**	5 to 4		0.8	"
	IOH2	23	0.8 V	4.5 V	30 V	"				"	"	3		300	μA
	I _{OH2}	24				"	30 V	0.8 V	4.5 V	"	"	5		300	"

TABLE III. Group A inspection for device type 08.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	Vcc		terminal	Min	Max	
2	VIC	25	-12 mA	4.5 V		GND				4.5 V	See figure	1 to 4		-1.5	V
T _A =	"	26	4.5 V	-12 mA		"				"	5 for test	2 to 4		"	"
+125°C	"	27				"		-12 mA	4.5 V	"	circuit	6 to 4		"	"
	"	28				**		4.5 V	-12 mA	"	"	7 to 4		"	"
	liH1	29	2.4 V	GND		"				5.5 V	"	1 to 4		40	μA
	"	30	GND	2.4 V		"				"	"	2 to 4		"	"
	"	31				"		2.4 V	GND	"	"	6 to 4		"	"
	"	32				"		GND	2.4 V	"	"	7 to 4		"	"
	I _{IH2}	33	5.5 V	GND		"				"	"	1 to 4		1	mA
	"	34	GND	5.5 V		"				"	**	2 to 4		"	"
	"	35				"		5.5 V	GND	"	"	6 to 4		"	"
	"	36				"		GND	5.5 V	"	"	7 to 4		"	"
	I _{IL1}	37	0.4 V	5.5 V		"				"	"	1 to 4		-1.6	mA
	"	38	5.5 V	0.4 V		"				"	"	2 to 4		"	"
	"	39				"		0.4 V	5.5 V	"	"	6 to 4		"	"
	"	40				"		5.5 V	0.4 V	"	"	7 to 4		"	"
	Ісснз	41	GND	GND		"		GND	GND	"	"	8		17	"
	I _{CCL6}	42	5.5 V	5.5 V		"		5.5 V	5.5 V	"	"	8		76	"
	V _{OL2}	43	2 V	2 V	100 mA	"				4.5 V	"	3 to 4		0.5	V
	Vol2	44				"	100 mA	2 V	2 V	"	"	5 to 4		0.5	"
	V _{OL6}	45	2 V	2 V	300 mA	"				"	"	3 to 4		0.8	"
	V _{OL6}	46				"	300 mA	2 V	2 V	"	**	5 to 4		0.8	"
	IOH2	47	0.8 V	4.5 V	30 V	"				"	"	3		300	μA
	I _{OH2}	48				"	30 V	0.8 V	4.5 V	"	66	5		300	"

 TABLE III.
 Group A inspection for device type 08
 - Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	Vcc		terminal	Min	Max	
3	VIC	49	-12 mA	4.5 V		GND				4.5 V	See figure	1 to 4		-1.5	V
T _A =	"	50	4.5 V	-12 mA		**				"	5 for test	2 to 4		"	"
-55°C	"	51				"		-12 mA	4.5 V	"	circuit	6 to 4		"	"
	"	52				**		4.5 V	-12 mA	"	66	7 to 4		"	"
	liH1	53	2.4 V	GND		"				5.5 V	66	1 to 4		40	μA
	**	54	GND	2.4 V		"				"	**	2 to 4		"	"
	"	55				**		2.4 V	GND	"	66	6 to 4		"	"
	"	56				**		GND	2.4 V	"	"	7 to 4		"	"
	I _{IH2}	57	5.5 V	GND		"				"	"	1 to 4		1	mA
	"	58	GND	5.5 V		"				"	66	2 to 4		"	"
	"	59				**		5.5 V	GND	"	"	6 to 4		"	"
	**	60				**		GND	5.5 V	"	**	7 to 4		"	"
	I _{IL1}	61	0.4 V	5.5 V		"				"	"	1 to 4		-1.6	mA
	"	62	5.5 V	0.4 V		"				"	66	2 to 4		"	"
	"	63				**		0.4 V	5.5 V	"	"	6 to 4		"	"
	"	64				**		5.5 V	0.4 V	"	66	7 to 4		"	"
	Ісснз	65	GND	GND		**		GND	GND	"	"	8		17	u
	ICCL6	66	5.5 V	5.5 V		**		5.5 V	5.5 V	"	66	8		76	"
	V _{OL2}	67	2 V	2 V	100 mA	"				4.5 V	66	3 to 4		0.5	V
	VOL2	68				**	100 mA	2 V	2 V	"	"	5 to 4		0.5	"
	V _{OL6}	69	2 V	2 V	300 mA	"				"	"	3 to 4		0.8	"
	V _{OL6}	70				**	300 mA	2 V	2 V	"	**	5 to 4		0.8	"
	IOH2	71	0.8 V	4.5 V	30 V	"				"	**	3		300	μA
	I _{OH2}	72				66	30 V	0.8 V	4.5 V	"	"	5		300	"

 TABLE III.
 Group A inspection for device type 08
 - Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	V _{CC}		terminal	Min	Max	
9	tPLH	73	IN	3 V	OUT	GND				4.5 V	See figure 9	1 to 3		65	ns
T _A =	"	74	3 V	IN	OUT	"				"	for test	2 to 3		"	"
+25°C	"	75				"	OUT	IN	3 V	"	circuit and	6 to 5		"	"
	"	76				"	OUT	3 V	IN	"	waveforms	7 to 5		**	"
	tPHL	77	IN	3 V	OUT	**				4.5 V	"	1 to 3		50	"
	"	78	3 V	IN	OUT	"				"	**	2 to 3		"	"
	"	79				"	OUT	IN	3 V	"	"	6 to 5		"	"
	"	80				"	OUT	3 V	IN	"	"	7 to 5		"	"
	t _{TLH}	81	IN	IN	OUT	**				"	"	3		25	"
	t _{TLH}	82				"	OUT	IN	IN	"	"	5		25	"
	t THL	83	IN	IN	OUT	**				"	"	3		20	"
	t _{THL}	84				"	OUT	IN	IN	"	**	5		20	"
10	tPLH	85	IN	3 V	OUT	GND				4.5 V	"	1 to 3		95	ns
T _A =	"	86	3 V	IN	OUT	"				"	"	2 to 3		**	"
+125°C	"	87				"	OUT	IN	3 V	"	**	6 to 5		"	"
	"	88				"	OUT	3 V	IN	"	"	7 to 5		**	"
	t PHL	89	IN	3 V	OUT	**				4.5 V	"	1 to 3		75	"
	"	90	3 V	IN	OUT	"				"	**	2 to 3		"	"
	"	91				"	OUT	IN	3 V	"	"	6 to 5		"	"
	"	92				"	OUT	3 V	IN	"	"	7 to 5		"	"
	t _{TLH}	93	IN	IN	OUT	"				"	"	3		33.5	"
	t _{TLH}	94				"	OUT	IN	IN	"	**	5		33.5	"
	t THL	95	IN	IN	OUT	**				"	**	3		35	"
	t _{THL}	96				"	OUT	IN	IN	"	"	5		35	"

 TABLE III.
 Group A inspection for device type 08
 - Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	V _{CC}		terminal	Min	Max	
11	tPLH	97	IN	3 V	OUT	GND				4.5 V	See figure 9	1 to 3		95	ns
T _A =	"	98	3 V	IN	OUT	"				"	for test	2 to 3		"	"
-55°C	"	99				"	OUT	IN	3 V	"	circuit and	6 to 5		u	"
	"	100				"	OUT	3 V	IN	"	waveforms	7 to 5		u	"
	t PHL	101	IN	3 V	OUT	**				4.5 V	"	1 to 3		75	"
	"	102	3 V	IN	OUT	**				"	£6	2 to 3		"	"
	"	103				"	OUT	IN	3 V	"	"	6 to 5		"	"
	"	104				"	OUT	3 V	IN	"	"	7 to 5		"	"
	t _{TLH}	105	IN	IN	OUT	**				"	£6	3		33.5	"
	tTLH	106				"	OUT	IN	IN	"	"	5		33.5	"
	t THL	107	IN	IN	OUT	**				"	"	3		35	**
	t _{THL}	108				"	OUT	IN	IN	"	"	5		35	"

 TABLE III.
 Group A inspection for device type 08
 - Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	V _{CC}		terminal	Min	Max	
1	VIC	1	-12 mA	4.5 V		GND				4.5 V	See figure	1 to 4		-1.5	V
T _A =	"	2	4.5 V	-12 mA		**				"	5 for test	2 to 4		"	"
+25°C	"	3				"		-12 mA	4.5 V	"	circuit	6 to 4		"	"
	"	4				"		4.5 V	-12 mA	"	**	7 to 4		"	"
	liH1	5	2.4 V	GND		"				5.5 V	"	1 to 4		40	μA
	"	6	GND	2.4 V		"				"	"	2 to 4		"	"
	"	7				"		2.4 V	GND	"	**	6 to 4		"	"
	"	8				**		GND	2.4 V	"	**	7 to 4		"	"
	I _{IH2}	9	5.5 V	GND		"				"	"	1 to 4		1	mA
	"	10	GND	5.5 V		"				"	**	2 to 4		"	"
	"	11				"		5.5 V	GND	"	"	6 to 4		"	"
	"	12				"		GND	5.5 V	"	"	7 to 4		"	"
	l _{IL1}	13	0.4 V	GND		"				"	**	1 to 4		-1.6	mA
	"	14	GND	0.4 V		"				"	**	2 to 4		"	"
	"	15				**		0.4 V	GND	"	**	6 to 4		"	"
	"	16				**		GND	0.4 V	"	**	7 to 4		"	"
	ICCH2	17	5.5 V	5.5 V		**		5.5 V	5.5 V	"	"	8		11	"
	I _{CCL5}	18	GND	GND		**		GND	GND	"	**	8		76	"
	V _{OL3}	19	0.8 V	0.8 V	100 mA	"				4.5 V	**	3 to 4		0.5	V
	VOL3	20				**	100 mA	0.8 V	0.8 V	"	**	5 to 4		0.5	"
	V _{OL7}	21	0.8 V	0.8 V	300 mA	"				"	"	3 to 4		0.8	"
	V _{OL7}	22				**	300 mA	0.8 V	0.8 V	"	**	5 to 4		0.8	"
	ЮНЗ	23	2 V	GND	30 V	"				"	"	3		300	μA
	I _{OH3}	24				"	30 V	2 V	GND	"	"	5		300	"

TABLE III. Group A inspection for device type 09.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	V _{CC}		terminal	Min	Max	
2	VIC	25	-12 mA	4.5 V		GND				4.5 V	See figure	1 to 4		-1.5	V
T _A =	"	26	4.5 V	-12 mA		"				"	5 for test	2 to 4		"	"
+125°C	"	27				"		-12 mA	4.5 V	"	circuit	6 to 4		"	"
	"	28				"		4.5 V	-12 mA	"	**	7 to 4		u	"
	liH1	29	2.4 V	GND		"				5.5 V	**	1 to 4		40	μA
	"	30	GND	2.4 V		"				"	"	2 to 4		"	"
	"	31				"		2.4 V	GND	"	**	6 to 4		"	"
	"	32				"		GND	2.4 V	"	**	7 to 4		"	"
	I _{IH2}	33	5.5 V	GND		"				"	"	1 to 4		1	mA
	"	34	GND	5.5 V		"				"	**	2 to 4		"	"
	"	35				"		5.5 V	GND	"	**	6 to 4		"	"
	"	36				"		GND	5.5 V	"	**	7 to 4		"	"
	l _{IL1}	37	0.4 V	GND		"				"	**	1 to 4		-1.6	mA
	"	38	GND	0.4 V		"				"	**	2 to 4		"	"
	"	39				"		0.4 V	GND	"	**	6 to 4		"	"
	"	40				"		GND	0.4 V	"	**	7 to 4		"	"
	ICCH2	41	5.5 V	5.5 V		"		5.5 V	5.5 V	"	"	8		11	"
	I _{CCL5}	42	GND	GND		"		GND	GND	"	**	8		76	"
	V _{OL3}	43	0.8 V	0.8 V	100 mA	"				4.5 V	**	3 to 4		0.5	V
	VOL3	44				"	100 mA	0.8 V	0.8 V	"	**	5 to 4		0.5	"
	V _{OL7}	45	0.8 V	0.8 V	300 mA	"				"	"	3 to 4		0.8	"
	V _{OL7}	46				"	300 mA	0.8 V	0.8 V	"	**	5 to 4		0.8	"
	ЮНЗ	47	2 V	GND	30 V	"				"	"	3		300	μA
	I _{OH3}	48				"	30 V	2 V	GND	"	"	5		300	"

 TABLE III.
 Group A inspection for device type 09
 - Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	V _{CC}		terminal	Min	Max	
3	VIC	49	-12 mA	4.5 V		GND				4.5 V	See figure	1 to 4		-1.5	V
T _A =	"	50	4.5 V	-12 mA		66				u	5 for test	2 to 4		u	"
-55°C	"	51				**		-12 mA	4.5 V	"	circuit	6 to 4		"	"
	"	52				**		4.5 V	-12 mA	"	**	7 to 4		u	"
	liH1	53	2.4 V	GND		"				5.5 V	**	1 to 4		40	μA
	"	54	GND	2.4 V		"				"	**	2 to 4		"	"
	"	55				**		2.4 V	GND	"	**	6 to 4		u	"
	"	56				**		GND	2.4 V	"	**	7 to 4		"	"
	I _{IH2}	57	5.5 V	GND		"				"	"	1 to 4		1	mA
	"	58	GND	5.5 V		"				"	**	2 to 4		"	"
	"	59				**		5.5 V	GND	"	**	6 to 4		"	"
	"	60				**		GND	5.5 V	"	**	7 to 4		"	"
	l _{IL1}	61	0.4 V	GND		"				"	**	1 to 4		-1.6	mA
	"	62	GND	0.4 V		"				"	**	2 to 4		"	"
	"	63				**		0.4 V	GND	"	**	6 to 4		"	"
	"	64				**		GND	0.4 V	"	**	7 to 4		"	"
	ICCH2	65	5.5 V	5.5 V		**		5.5 V	5.5 V	"	"	8		11	"
	I _{CCL5}	66	GND	GND		**		GND	GND	"	**	8		76	"
	V _{OL3}	67	0.8 V	0.8 V	100 mA	"				4.5 V	**	3 to 4		0.5	V
	VOL3	68				**	100 mA	0.8 V	0.8 V	"	**	5 to 4		0.5	"
	V _{OL7}	69	0.8 V	0.8 V	300 mA	"				"	"	3 to 4		0.8	"
	V _{OL7}	70				"	300 mA	0.8 V	0.8 V	"	**	5 to 4		0.8	"
	ЮНЗ	71	2 V	GND	30 V	"				"	"	3		300	μA
	I _{OH3}	72				"	30 V	2 V	GND	"	"	5		300	"

 TABLE III.
 Group A inspection for device type 09
 - Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	V _{CC}		terminal	Min	Max	
9	tPLH	73	IN	GND	OUT	GND				4.5 V	See figure 9	1 to 3		55	ns
T _A =	"	74	GND	IN	OUT	"				"	for test	2 to 3		"	"
+25°C	"	75				"	OUT	IN	GND	"	circuit and	6 to 5		"	"
	"	76				"	OUT	GND	IN	"	waveforms	7 to 5		"	**
	tPHL	77	IN	GND	OUT	**				4.5 V	"	1 to 3		40	"
	"	78	GND	IN	OUT	"				"	55	2 to 3		"	**
	"	79				"	OUT	IN	GND	"	"	6 to 5		**	**
	"	80				"	OUT	GND	IN	"	"	7 to 5		**	**
	t _{TLH}	81	IN	IN	OUT	**				"	"	3		25	"
	t _{TLH}	82				"	OUT	IN	IN	"	"	5		**	**
	t THL	83	IN	IN	OUT	"				"	"	3		**	**
	t _{THL}	84				"	OUT	IN	IN	"	"	5		**	"
10	tPLH	85	IN	GND	OUT	GND				4.5 V	66	1 to 3		70	ns
T _A =	"	86	GND	IN	OUT	"				"	"	2 to 3		**	"
+125°C	"	87				"	OUT	IN	GND	"	"	6 to 5		**	"
	"	88				"	OUT	GND	IN	"	"	7 to 5		"	"
	t PHL	89	IN	GND	OUT	**				4.5 V	"	1 to 3		60	"
	"	90	GND	IN	OUT	"				"	"	2 to 3		**	**
	"	91				"	OUT	IN	GND	"	"	6 to 5		**	"
	"	92				"	OUT	GND	IN	"	"	7 to 5		**	**
	t _{TLH}	93	IN	IN	OUT	**				"	"	3		33.5	"
	t _{TLH}	94				"	OUT	IN	IN	"	"	5		33.5	"
	t THL	95	IN	IN	OUT	**				"	"	3		25	"
	t _{THL}	96				"	OUT	IN	IN	"	"	5		25	**

 TABLE III.
 Group A inspection for device type 09
 - Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	V _{CC}		terminal	Min	Max	
11	t _{PLH}	97	IN	GND	OUT	GND				4.5 V	See figure 9	1 to 3		70	ns
T _A =	"	98	GND	IN	OUT	"				"	for test	2 to 3		"	"
-55°C	"	99				"	OUT	IN	GND	"	circuit and	6 to 5		"	"
	"	100				"	OUT	GND	IN	"	waveforms	7 to 5		"	"
	tPHL	101	IN	GND	OUT	**				4.5 V	"	1 to 3		60	"
	"	102	GND	IN	OUT	**				"	"	2 to 3		"	"
	"	103				"	OUT	IN	GND	"	"	6 to 5		"	"
	"	104				"	OUT	GND	IN	"	"	7 to 5		"	"
	t _{TLH}	105	IN	IN	OUT	**				"	"	3		33.5	"
	t _{TLH}	106				"	OUT	IN	IN	"	"	5		33.5	"
	t THL	107	IN	IN	OUT	**				"	"	3		25	"
	t _{THL}	108				"	OUT	IN	IN	"	"	5		25	"

TABLE III. Group A inspection for device type 09 - Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	V _{CC}		terminal	Min	Max	
1	VIC	1	-12 mA	4.5 V		GND				4.5 V	See figure	1 to 4		-1.5	V
T _A =	"	2	4.5 V	-12 mA		"				"	5 for test	2 to 4		"	"
+25°C	"	3				"		-12 mA	4.5 V	"	circuit	6 to 4		"	"
	"	4				**		4.5 V	-12 mA	u	66	7 to 4		"	"
	liH1	5	2.4 V	GND		**				5.5 V	**	1 to 4		40	μA
	**	6	GND	2.4 V		**				"	**	2 to 4		"	"
	"	7				**		2.4 V	GND	u	66	6 to 4		"	"
	**	8				"		GND	2.4 V	"	**	7 to 4		"	"
	I _{IH2}	9	5.5 V	GND		**				"	"	1 to 4		1	mA
	"	10	GND	5.5 V		**				u	66	2 to 4		"	"
	**	11				"		5.5 V	GND	"	**	6 to 4		"	"
	**	12				"		GND	5.5 V	"	**	7 to 4		"	"
	I _{IL1}	13	0.4 V	GND		**				"	"	1 to 4		-1.6	mA
	"	14	GND	0.4 V		**				"	"	2 to 4		"	"
	**	15				"		0.4 V	GND	"	**	6 to 4		"	"
	"	16				"		GND	0.4 V	"	"	7 to 4		"	"
	ICCH5	17	GND	GND		"		GND	GND	"	"	8		19	"
	I _{CCL8}	18	5.5 V	5.5 V		"		5.5 V	5.5 V	"	**	8		85	"
	V _{OL4}	19	2 V	2 V	100 mA	**				4.5 V	"	3 to 4		0.5	V
	VOL4	20				"	100 mA	2 V	2 V	"	**	5 to 4		0.5	"
	V _{OL8}	21	2 V	2 V	300 mA	"				"	"	3 to 4		0.8	"
	V _{OL8}	22				**	300 mA	2 V	2 V	"	**	5 to 4		0.8	"
	IOH4	23	0.8 V	0.8 V	30 V	"				"	**	3		300	μA
	I _{OH4}	24				"	30 V	0.8 V	0.8 V	"	"	5		300	"

TABLE III. Group A inspection for device type 10.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	V _{CC}		terminal	Min	Max	
2	VIC	25	-12 mA	4.5 V		GND				4.5 V	See figure	1 to 4		-1.5	V
T _A =	"	26	4.5 V	-12 mA		**				"	5 for test	2 to 4		"	"
+125°C	**	27				**		-12 mA	4.5 V	"	circuit	6 to 4		"	"
	"	28				**		4.5 V	-12 mA	"	66	7 to 4		"	"
	liH1	29	2.4 V	GND		"				5.5 V	66	1 to 4		40	μA
	"	30	GND	2.4 V		"				"	"	2 to 4		"	"
	"	31				**		2.4 V	GND	"	66	6 to 4		"	"
	"	32				**		GND	2.4 V	u	66	7 to 4		"	"
	I _{IH2}	33	5.5 V	GND		"				"	"	1 to 4		1	mA
	"	34	GND	5.5 V		"				u	66	2 to 4		"	"
	"	35				**		5.5 V	GND	"	"	6 to 4		"	"
	"	36				**		GND	5.5 V	"	"	7 to 4		"	"
	I _{IL1}	37	0.4 V	GND		"				"	"	1 to 4		-1.6	mA
	"	38	GND	0.4 V		"				u	66	2 to 4		"	"
	"	39				**		0.4 V	GND	"	"	6 to 4		"	"
	"	40				**		GND	0.4 V	u	66	7 to 4		"	"
	ICCH5	41	GND	GND		**		GND	GND	u	"	8		19	"
	ICCL8	42	5.5 V	5.5 V		**		5.5 V	5.5 V	u	66	8		85	"
	V _{OL4}	43	2 V	2 V	100 mA	"				4.5 V	66	3 to 4		0.5	V
	VOL4	44				**	100 mA	2 V	2 V	"	**	5 to 4		0.5	"
	V _{OL8}	45	2 V	2 V	300 mA	"				"	"	3 to 4		0.8	"
	V _{OL8}	46				66	300 mA	2 V	2 V	"	66	5 to 4		0.8	"
	IOH4	47	0.8 V	0.8 V	30 V	"				"	66	3		300	μΑ
	I _{OH4}	48				66	30 V	0.8 V	0.8 V	"	66	5		300	"

 TABLE III.
 Group A inspection for device type 10
 - Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	V _{CC}		terminal	Min	Max	
3	VIC	49	-12 mA	4.5 V		GND				4.5 V	See figure	1 to 4		-1.5	V
T _A =	"	50	4.5 V	-12 mA		"				"	5 for test	2 to 4		"	"
-55°C	"	51				"		-12 mA	4.5 V	"	circuit	6 to 4		"	"
	**	52				"		4.5 V	-12 mA	"	**	7 to 4		"	"
	liH1	53	2.4 V	GND		"				5.5 V	**	1 to 4		40	μA
	"	54	GND	2.4 V		"				"	"	2 to 4		"	"
	**	55				"		2.4 V	GND	"	**	6 to 4		"	"
	**	56				"		GND	2.4 V	"	**	7 to 4		"	"
	I _{IH2}	57	5.5 V	GND		"				"	"	1 to 4		1	mA
	**	58	GND	5.5 V		"				"	**	2 to 4		"	"
	"	59				"		5.5 V	GND	"	"	6 to 4		"	"
	"	60				"		GND	5.5 V	"	"	7 to 4		"	"
	I _{IL1}	61	0.4 V	GND		"				"	"	1 to 4		-1.6	mA
	**	62	GND	0.4 V		"				"	**	2 to 4		"	"
	"	63				"		0.4 V	GND	"	"	6 to 4		"	"
	**	64				"		GND	0.4 V	"	**	7 to 4		"	"
	ICCH5	65	GND	GND		"		GND	GND	"	"	8		19	"
	I _{CCL8}	66	5.5 V	5.5 V		"		5.5 V	5.5 V	"	**	8		85	"
	V _{OL4}	67	2 V	2 V	100 mA	"				4.5 V	"	3 to 4		0.5	V
	VOL4	68				"	100 mA	2 V	2 V	"	"	5 to 4		0.5	"
	V _{OL8}	69	2 V	2 V	300 mA	"				"	**	3 to 4		0.8	"
	V _{OL8}	70				"	300 mA	2 V	2 V	"	**	5 to 4		0.8	"
	IOH4	71	0.8 V	0.8 V	30 V	"				"	**	3		300	μA
	I _{OH4}	72				"	30 V	0.8 V	0.8 V	"	"	5		300	"

 TABLE III.
 Group A inspection for device type 10
 - Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	V _{CC}		terminal	Min	Max	
9	t _{PLH}	73	IN	GND	OUT	GND				4.5 V	See figure 9	1 to 3		65	ns
T _A =	"	74	GND	IN	OUT	"				"	for test	2 to 3		"	"
+25°C	"	75				"	OUT	IN	GND	"	circuit and	6 to 5		"	"
	"	76				"	OUT	GND	IN	"	waveforms	7 to 5		"	"
	tPHL	77	IN	GND	OUT	"				4.5 V	"	1 to 3		50	"
	"	78	GND	IN	OUT	"				"	56	2 to 3		"	"
	"	79				"	OUT	IN	GND	"	"	6 to 5		"	"
	"	80				"	OUT	GND	IN	"	"	7 to 5		"	"
	t _{TLH}	81	IN	IN	OUT	"				"	"	3		20	"
	t _{TLH}	82				"	OUT	IN	IN	"	"	5		u	"
	t THL	83	IN	IN	OUT	"				"	"	3		"	"
	t _{THL}	84				"	OUT	IN	IN	"	"	5		"	"
10	tPLH	85	IN	GND	OUT	GND				4.5 V	66	1 to 3		90	ns
T _A =	"	86	GND	IN	OUT	"				"	"	2 to 3		u	"
+125°C	"	87				"	OUT	IN	GND	"	"	6 to 5		"	"
	"	88				"	OUT	GND	IN	"	"	7 to 5		u	"
	t PHL	89	IN	GND	OUT	"				4.5 V	"	1 to 3		75	"
	"	90	GND	IN	OUT	"				"	"	2 to 3		"	"
	"	91				"	OUT	IN	GND	"	"	6 to 5		"	"
	"	92				"	OUT	GND	IN	"	"	7 to 5		"	"
	t _{TLH}	93	IN	IN	OUT	"				"	"	3		26.5	"
	t _{TLH}	94				"	OUT	IN	IN	"	"	5		26.5	"
	t THL	95	IN	IN	OUT	"				"	"	3		25	**
	t _{THL}	96				"	OUT	IN	IN	"	"	5		25	"

TABLE III. <u>Group A inspection for device type 10</u> – Continued.

Subgroup	Symbol	Test	1	2	3	4	5	6	7	8	Notes	Measured	Test	limits	Unit
		no.	1A	1B	1Y	GND	2Y	2A	2B	V _{CC}		terminal	Min	Max	
11	tPLH	97	IN	GND	OUT	GND				4.5 V	See figure9	1 to 3		90	ns
T _A =	"	98	GND	IN	OUT	"				"	for test	2 to 3		"	"
-55°C	"	99				"	OUT	IN	GND	"	circuit and	6 to 5		"	"
	"	100				"	OUT	GND	IN	"	waveforms	7 to 5		"	"
	tPHL	101	IN	GND	OUT	**				4.5 V	"	1 to 3		75	"
	"	102	GND	IN	OUT	**				"	66	2 to 3		"	"
	"	103				"	OUT	IN	GND	"	"	6 to 5		"	u
	"	104				"	OUT	GND	IN	"	"	7 to 5		"	"
	t _{TLH}	105	IN	IN	OUT	**				"	66	3		26.5	"
	t _{TLH}	106				"	OUT	IN	IN	"	**	5		26.5	"
	t THL	107	IN	IN	OUT	**				"	**	3		25	"
	t _{THL}	108				"	OUT	IN	IN	"	**	5		25	"

TABLE III. Group A inspection for device type 10 - Continued.

4.4 <u>Technology Conformance inspection (TCI)</u>. Technology conformance inspection shall be in accordance with MIL-PRF-38535 and herein for groups A, B, C, and D inspections (see 4.4.1 through 4.4.4).

4.4.1 Group A inspection. Group A inspection shall be in accordance with table III of MIL-PRF-38535 and as follows:

- a. Tests shall be as specified in table II herein.
- b. Subgroups 4, 5, 6, 7, and 8 in table I shall be omitted.
- 4.4.2 Group B inspection. Group B inspection shall be in accordance with table II of MIL-PRF-38535.

4.4.3 Group C inspection. Group C inspection shall be in accordance with table IV of MIL-PRF-38535 and as follows:

- a. End point electrical parameters shall be as specified in table II herein.
- b. The steady-state life test duration, test condition, and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document control by the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.

4.4.4 <u>Group D inspection</u>. Group D inspection shall be in accordance with table V of MIL-PRF-38535. End point electrical parameters shall be as specified in table II herein.

4.5 <u>Methods of inspection</u>. Methods of inspection shall be specified and as follows.

4.5.1 <u>Voltage and current</u>. All voltage values given are referenced to the ground terminal of the device under test (DUT). Currents values given are for conventional current and are positive when flowing into the referenced terminal.

5. PACKAGING

5.1 <u>Packaging requirements.</u> For acquisition purposes, the packaging requirements shall be as specified in the contract or order (see 6.2). When actual packaging of materiel is to be performed by DoD personnel, these personnel need to contact the responsible packaging activity to ascertain requisite packaging requirements. Packaging requirements are maintained by the Inventory Control Point's packaging activity within the Military Department of Defense Agency, or within the Military Department's System Command. Packaging data retrieval is available from the managing Military Department's or Defense Agency's automated packaging files, CD-ROM products, or by contacting the responsible packaging activity.

TABLE IV. Group C end-point electrical parameters.

$\pm V_{CC} = \pm 4.5 \text{ V}, \text{ T}_{A} = +25^{\circ}\text{C}$

Test	Lin	nits	Delta	Unit
	Min	Max		
IОН		300	±50	μΑ

(Device types 01 through 10)

6. NOTES

6.1 <u>Intended use.</u> Microcircuits conforming to this specification are intended for original equipment design applications and logistic support of existing equipment.

- 6.2 <u>Acquisition requirements</u>. Acquisition documents should specify the following:
 - a. Title, number, and date of the specification.
 - b. Pin and compliance identifier, if applicable (see 1.2).
 - c. Requirements for delivery of one copy of the conformance inspection data pertinent to the device inspection lot to be supplied with each shipment by the device manufacturer, if applicable.
 - d. Requirements for certificate of compliance, if applicable.
 - e. Requirements for notification of change of product or process to acquiring activity in addition to notification of the qualifying activity, if applicable.
 - f. Requirements for failure analysis (including required test condition of MIL-STD-883, method 5003), corrective action and reporting of results, if applicable.
 - g. Requirements for product assurance options.
 - h. Requirements for special carriers, lead lengths, or lead forming, if applicable. These requirements should not affect the part number. Unless otherwise specified, these requirements will not apply to direct purchase by or direct shipment to the Government.
 - i. Requirements for "JAN" marking.
 - j. Packaging requirements (see 5.1).

6.3 <u>Superseding information</u>. The requirements of MIL-M-38510 have been superseded to take advantage of the available Qualified Manufacturer Listing (QML) system provided by MIL-PRF-38535. Previous references to MIL-M-38510 in this document have been replaced by appropriate references to MIL-PRF-38535. All technical requirements now consist of this specification and MIL-PRF-38535. The MIL-M-38510 specification sheet number and PIN have been retained to avoid adversely impacting existing government logistics systems and contractor's parts lists.

6.4 <u>Qualification</u>. With respect to products requiring qualification, awards will be made only for products which are, at the time of award of contract, qualified for inclusion in Qualified Manufacturers List QML-38535 whether or not such products have actually been so listed by that date. The attention of the contractors is called to these requirements, and manufacturers are urged to arrange to have the products that they propose to offer to the Federal Government tested for qualification in order that they may be eligible to be awarded contracts or purchase orders for the products covered by this specification. Information pertaining to qualification of products may be obtained from DSCC-VQ, 3990 E. Broad Street, Columbus, Ohio 43218-3990.

6.5 <u>Abbreviations, symbols, and definitions</u>. The abbreviations, symbols, and definitions used herein are defined in MIL-PRF-38535, MIL-STD-1331, and as follows:

- VIC Input clamp voltage.
- I_{IH} High level input current ($V_{IN} = 2.4 \text{ or } 5.5 \text{ V}$).
- I_{IL} Low level input current (with $V_{IN} = 0.4$).
- I_{CCH} High level supply current. This is the supply current with the output high.
- I_{CCL} Low level supply current. This is the supply current with the output low.
- V_{OL} Low level output voltage. This at rated load for the TTL gates.
- IOH High level output current.
- VOH High level output voltage, TTL gate.
- IOS Short circuit output current TTL gate.
- V_{CBO} Collector base breakdown voltage, separate transistor.
- V_{CER} Collector base breakdown voltage with R_{BE} = 500 ohms.
- VCEO Collector emitter breakdown voltage.
- VBEO Emitter base breakdown voltage.
- h_{FE} Static forward current transfer ratio.
- VBE Base emitter voltage.
- V_{CE(SAT)} Collector emitter saturation voltage.
 - tD Delay time.
 - t_R Rise time.
 - ts Storage time.
 - t_F Fall time.
 - t_{PLH} Propagation delay time (low to high level output transition).
 - t_{PHL} Propagation delay time (high to low level output transition).
 - t_{TLH} Transition time (low to high level output transition).
 - t_{THL} Transition time (high to low level output transition).

6.6 Logistic support. Lead materials and finishes (see 3.3) are interchangeable. Unless otherwise specified, microcircuits acquired for Government logistic support will be acquired to device class B (see 1.2.2), lead material and finish A (see 3.4). Longer length leads and lead forming should not affect the part number.

6.7 <u>Substitutability</u>. The cross-reference information below is presented for the convenience of users. Microcircuits covered by this specification will functionally replace the listed generic-industry type. Generic-industry microcircuit types may not have equivalent operational performance characteristics across military temperature ranges or reliability factors equivalent to MIL-M-38510 device types and may have slight physical variations in relation to case size. The presence of this information should not be deemed as permitting substitution of generic-industry types for MIL-M-38510 types or as a waiver of any of the provisions of MIL-PRF-38535.

Military device type	Generic-industry type						
01	55450						
02	55451						
03	55452						
04	55453						
05	55454						
06	55460						
07	55461						
08	55462						
09	55463						
10	55464						

6.8 <u>Changes from previous issue</u>. Marginal notations are not used in this revision to identify changes with respect to the previous issue, due to the extensiveness of the changes.

Custodians: Army – CR Navy - EC Air Force - 11 NASA - NA DLA – CC Preparing activity: DLA - CC Project 5962-2081

Review activities: Army - MI, SM Navy - AS, CG, SH, TD Air Force – 03, 19, 99

NOTE: The activities listed above were interested in this document as of this date of this document. Since organizations and responsibilities can change, you should verify the currency of the information above using the ASSIST Online database at http://assist.daps.dla.mil.